

LV8726TA

Stepper Motor Pre-Driver, PWM, Constant-Current Control, Micro step

Overview

The LV8726 is a bipolar stepper motor driver with ultra-small micro step drive capability. The device uses external dual H-bridges consisting of P and N channel MOSFETs. The operation voltage range is from 9V to 55V, and it is applicable to various industrial applications. Synchronous rectification control is implemented for all H-bridges to minimize power dissipation during a MOSFET switching.

The device implements constant-current control using PWM. The step advance sequencer covers from half step to 1/128 micro step, and is driven by a clock input.

The configuration registers can be programmed through an SPI serial interface. To enhance energy efficiency further, the device can be put into a power saving standby mode.

Features

- H-bridge gate drivers
 - For bipolar stepper motor
 - Clockwise(CW) and Counter-clockwise(CCW) direction control
 - Built-in step vector, selectable number of step resolutions from 2, 3, 4, 5, 6, 8, 10, 12, 16, 20, 32, 36, 50, 64, 100 and 128
 - Constant-current control
 - Synchronous rectification to reduce power dissipation
- Single clock input to advance the excitation step
- Low power 1 μ A(max) standby mode
- Separate power supplies for control logic (3.3-5V) and motor drivers (9V – 55V)
- SPI 8-bit 3-wire serial interface for system configuration
- Input pins for standby and active mode
- Built-in system protection features such as:
 - Under-voltage
 - Over-current
 - Over-temperature

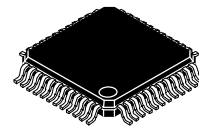
Typical Applications

- Textile machines
- Packing machines
- Large printers
- Engraving machines
- Industrial products



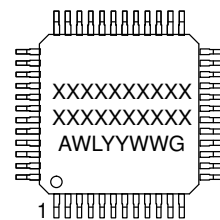
ON Semiconductor[®]

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48-pin TQFP with exposed pad
7 mm x 7 mm

MARKING DIAGRAM



XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Ordering Code:
LV8726TA-NH

Package
TQFP48 EP
(Pb-Free / Halogen Free)

Shipping (Qty / packing)
1000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

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BLOCK DIAGRAM

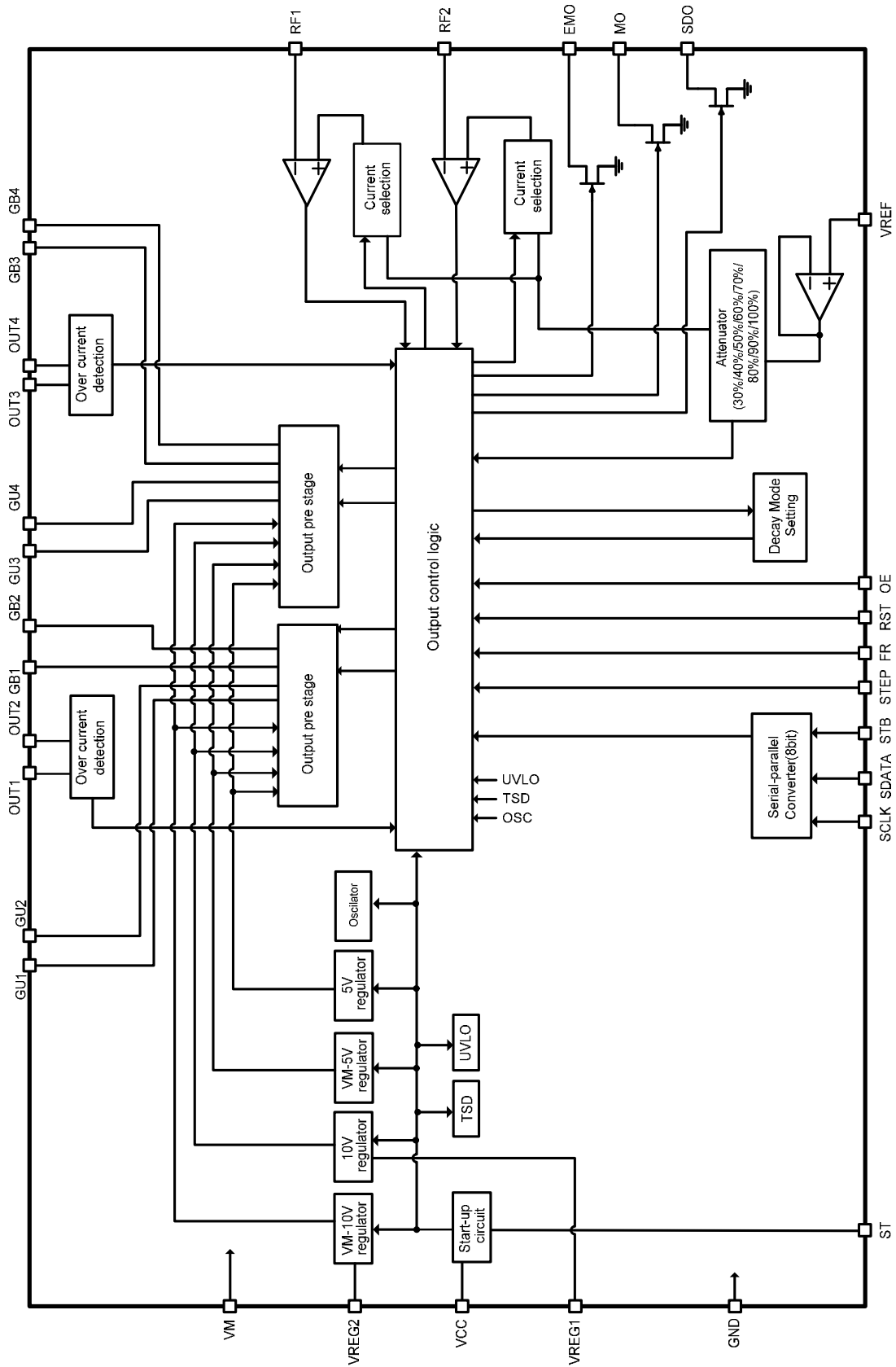


Figure 1. Block Diagram

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APPLICATION CIRCUIT EXAMPLE

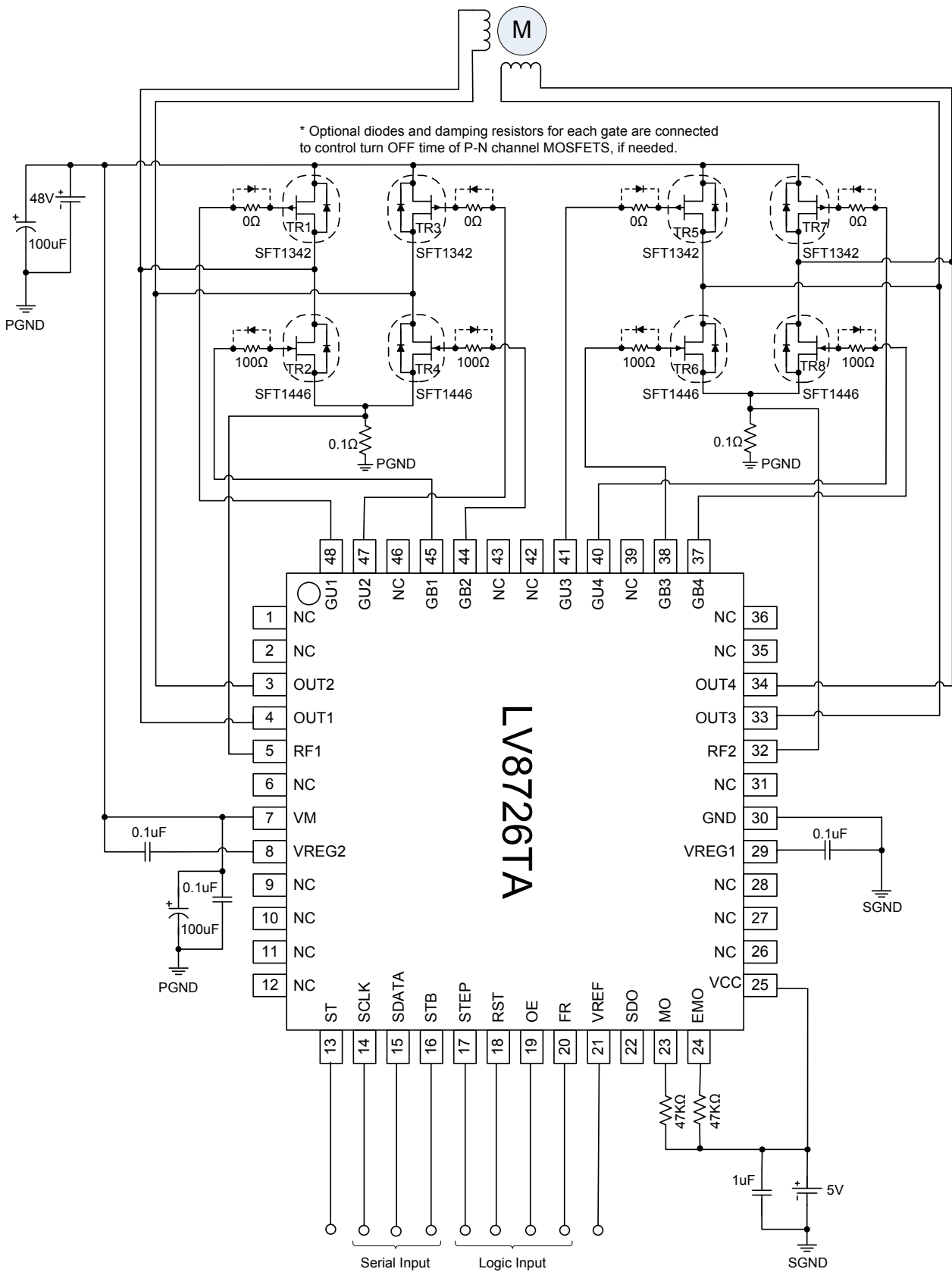


Figure 2. Application Circuit Example

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PIN ASSIGNMENT

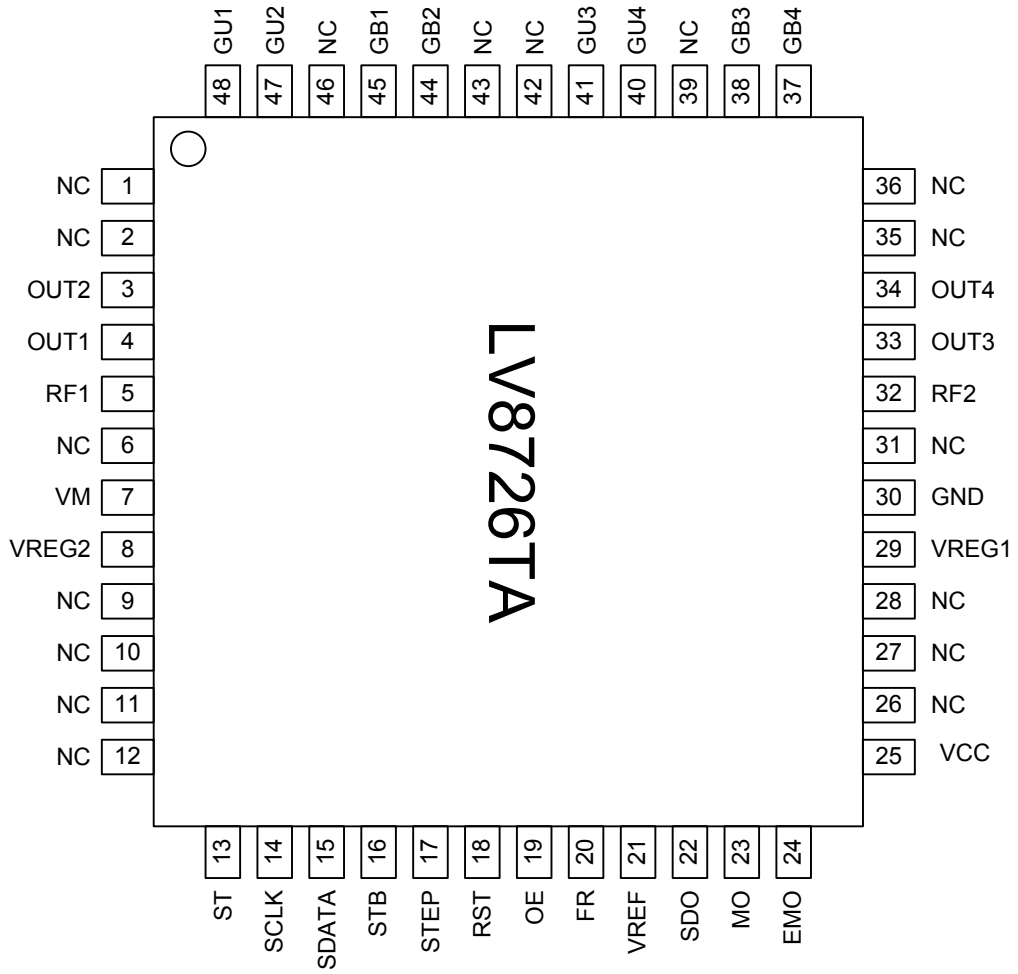


Figure 3. Pin Assignment

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PIN FUNCTION DISCRPTION

Pin No.	Pin Name	Description
1	NC	No connection
2	NC	No connection
3	OUT2	OUT2 voltage detection pin
4	OUT1	OUT1 voltage detection pin
5	RF1	Channel 1 Output current detection pin
6	NC	No connection
7	VM	Motor power supply pin
8	VREG2	Internal regulator capacitor connection pin for high side FET drive
9	NC	No connection
10	NC	No connection
11	NC	No connection
12	NC	No connection
13	ST	Chip enable pin.
14	SCLK	Serial data transfer clock input
15	SDATA	Serial data input
16	STB	Serial data latch pulse input
17	STEP	Step clock signal input pin
18	RST	Reset signal input pin
19	OE	Output enable signal input pin
20	FR	Direction control signal input pin
21	VREF	Constant-current control reference voltage input pin.
22	SDO	STEP detection output pin
23	MO	Position detecting monitor pin
24	EMO	Unusual condition warning output pins
25	VCC	Logic power supply pin
26	NC	No connection
27	NC	No connection
28	NC	No connection
29	VREG1	Internal regulator capacitor connection pin for low side FET drive
30	GND	GND pin
31	NC	No connection
32	RF2	Channel 2 Output current detection pin
33	OUT3	OUT3 voltage detection pin
34	OUT4	OUT4 voltage detection pin
35	NC	No connection
36	NC	No connection
37	GB4	Output terminal for low side gate drive 4
38	GB3	Output terminal for low side gate drive 3
39	NC	No connection
40	GU4	Output terminal for high side gate drive 4
41	GU3	Output terminal for high side gate drive 3
42	NC	No connection
43	NC	No connection
44	GB2	Output terminal for low side gate drive 2
45	GB1	Output terminal for low side gate drive 1
46	NC	No connection
47	GU2	Output terminal for high side gate drive 2
48	GU1	Output terminal for high side gate drive 1

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PIN EQUIVALENT CIRCUITS

Pin No.	Pin Name	Equivalent Circuit
13	ST	
14 15 16 17 18 19 20	SCLK SDATA STB STEP RST OE FR	
21	VREF	

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Pin No.	Pin Name	Equivalent Circuit
22 23 24	SDO MO EMO	<p style="text-align: center;">GND</p>
29	VREG1	<p style="text-align: center;">GND</p>
8	VREG2	<p style="text-align: center;">GND</p>

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Pin No.	Pin Name	Equivalent Circuit
5 32	RF1 RF2	
40 41 47 48	GU4 GU3 GU2 GU1	
37 38 44 45	GB4 GB3 GB2 GB1	
3 4 33 34	OUT2 OUT1 OUT3 OUT4	

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MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Motor Supply Voltage (VM)	V _M	60	V
Logic Supply Voltage (VCC)	V _{CC}	6	V
Logic Input Voltage (ST, SCLK, SDATA, STB, STEP, RST, OE, FR)	V _{IN}	6	V
Output current (GU1, GU2, GU3, GU4, GB1, GB2, GB3, GB4)	I _O	50	mA
Reference input voltage (VREF)	V _{REF}	6	C
Allowable Power Dissipation (Note 2)	P _d	3.35	W
Storage Temperature	T _{stg}	-55 to 150	°C
Junction Temperature	T _J	150	°C
Moisture Sensitivity Level (MSL) (Note 3)	MSL	3	-
Lead Temperature Soldering Pb-Free Versions (10sec or less) (Note 4)	T _{SLD}	260	°C
ESD Human Body Model: HBM (Note 5)	ESD _{HBM}	±2000	V
ESD Charged Device Model: CDM (Note 6)	ESD _{CDM}	±500	V

- Stresses exceeding those listed in the Absolute Maximum Rating table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
- Specified circuit board: 90mm× 90mm× 1.6mm, glass epoxy 2-layer board, with backside mounting. It has 1 oz copper traces on top and bottom of the board.
- Moisture Sensitivity Level (MSL): 3 per IPC/JEDEC standard: J-STD-020A
- For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D <http://www.onsemi.com/pub link/Collateral/SOLDERRM-D.PDF>
- ESD Human Body Model is based on JEDEC standard: JESD22-A114
- ESD Charge Device Model is based on JEDEC standard: JESD22-C101

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient (Note 2)	R _{θJA}	37.3	°C/W
Thermal Resistance, Junction-to-Ambient (Note 7)		56.8	°C/W
Thermal Resistance, Junction-to-Case (Top) (Note 2)	R _{ψJT}	4.8	°C/W
Thermal Resistance, Junction-to-Case (Top) (Note 7)		14.9	°C/W

- Specified circuit board: 90mm× 90mm× 1.6mm, glass epoxy 2-layer board, without backside mounting. It has 1 oz copper traces on top and bottom of the board.

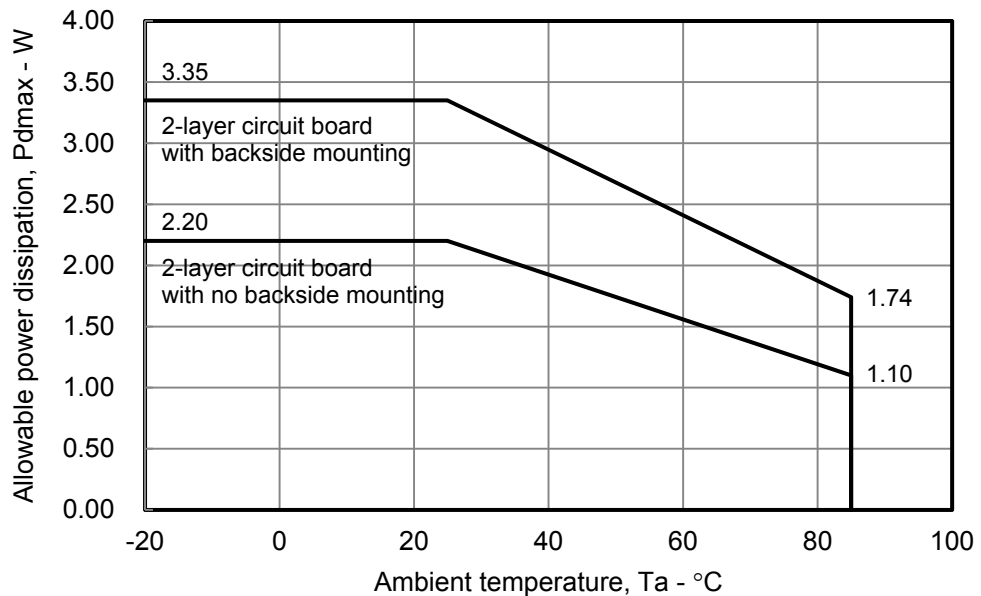


Figure 4. Power Dissipation vs Ambient Temperature Characteristic

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RECOMMENDED OPERATING RANGES (Note 8)

Parameter	Symbol	Ratings	Unit
Motor Supply Voltage Range (VM)	VM	9 to 55	V
Logic Supply Voltage Range (VCC)	VCC	2.7 to 5.5	V
Logic Input Voltage Range (ST, SCLK, SDATA, STB, STEP, RST, OE, FR)	VIN	0 to VCC	V
VREF Input Voltage Range (3.8V ≤ VCC ≤ 5.5V)	VREF	0 to 2.0	V
VREF Input Voltage Range (2.7V ≤ VCC ≤ 3.8V)		0 to VCC – 1.8	V
Ambient Temperature	TA	–40 to 85	°C

8. Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS

TA=25°C, VM = 48V, VCC=5V, VREF=1.5V unless otherwise noted. (Note 9)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Standby Mode Current	IMstn	ST="L", No load			1	μA
	ICCstn	ST="L", No load			1	μA
Supply Current	IM	ST="H", OE="L", RST="L", No load		1.6	2.3	mA
	ICC	ST="H", OE="L", RST="L", No load		1.7	2.3	mA
Thermal Shutdown Temperature	TSD	Guaranteed by design	150	180	210	°C
Thermal hysteresis	ΔTSD	Guaranteed by design		40		°C
Under-voltage Monitor						
VCC under-voltage threshold	Vthvc	VCC falling		2.3	2.45	V
	Vrevc	VCC rising		2.5	2.7	V
VM under-voltage threshold	Vthvm	VM falling		7.6	8.4	V
	Vrevm	VM rising		7.85	8.7	V
Regulator						
REG10 Output Voltage	VREG1		9.4	10	10.6	V
VM-10V Output Voltage	VREG2		37	38	39	V
MOSFET Drivers						
High Side Output On Resistance	RonH1	GU1, GU2, GU3, GU4-source Io=-10mA		20	32	Ω
	RonH2	GU1, GU2, GU3, GU4-sink Io=10mA		25	40	Ω
Low Side Output On Resistance	RonL1	GB1, GB2, GB3, GB4-source side Io=-10mA		20	32	Ω
	RonL2	GB1, GB2, GB3, GB4-sink side Io=10mA		25	40	Ω
Logic Inputs						
Logic Input Current	IINL	ST, SCLK, SDATA, STB, STEP, RST, OE, FR VIN=0.8V	4	8	12	μA
	IINH	ST, SCLK, SDATA, STB, STEP, RST, OE, FR VIN=5V	30	50	70	μA
Logic Input Voltage	High	VINH	2.0		5.5	V
	Low	VINL	0		0.8	V
System Monitoring						
Step signal OFF detection time	TSDO0	No rising edge in STEP pin Register D[7]='0', D[1:0]='01'	0.39	0.52	0.65	S
	TSDO1	No rising edge in STEP pin Register D[7]='1', D[1:0]='01'	0.78	1.04	1.3	S

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Parameter	Symbol	Condition	Min	Typ	Max	Unit
PWM Current Control						
VREF Pin Input Current	I _{REF}	V _{REF} =1.5V	-0.5		0	μA
Current setting comparator threshold voltage	V _{REF000}	Register D[4:2]='000', D[1:0]='01'	0.291	0.3	0.309	V
	V _{REF001}	Register D[4:2]='001', D[1:0]='01'	0.261	0.27	0.279	V
	V _{REF010}	Register D[4:2]='010', D[1:0]='01'	0.231	0.24	0.248	V
	V _{REF011}	Register D[4:2]='011', D[1:0]='01'	0.201	0.21	0.218	V
	V _{REF100}	Register D[4:2]='100', D[1:0]='01'	0.172	0.18	0.188	V
	V _{REF101}	Register D[4:2]='101', D[1:0]='01'	0.142	0.15	0.158	V
	V _{REF110}	Register D[4:2]='110', D[1:0]='01'	0.112	0.12	0.128	V
	V _{REF111}	Register D[4:2]='111', D[1:0]='01'	0.082	0.09	0.098	V
PWM (Chopping) Period	F _{chop1}	Register D[7:6]='00', D[1:0]='10'	6	8	10	μs
	F _{chop2}	Register D[7:6]='01', D[1:0]='10'	12	16	20	μs
	F _{chop3}	Register D[7:6]='10', D[1:0]='10'	18	24	30	μs
	F _{chop4}	Register D[7:6]='11', D[1:0]='10'	24	32	40	μs
Open Drain Outputs						
SDO pin saturation voltage	V _{satsdo}	I _{sod} =1mA			400	mV
MO pin saturation voltage	V _{satmo}	I _{mo} =1mA			400	mV
EMO pin saturation voltage	V _{satemo}	I _{emo} =1mA			400	mV
Serial Data Interface (Note 10)						
SCLK "H" Pulse Width	T _{ckh}		0.125			μs
SCLK "L" Pulse Width	T _{ckl}		0.125			μs
SCLK start setup time	T _{sup1}	STB=Low -> SCLK rising edge	0.125			μs
STB setup time	T _{sup2}	SCLK rising edge -> STB rising edge	0.125			μs
Serial Packet STB Interval	T _{stbw}		0.125			μs
SDATA setup time	T _{ds}		0.125			μs
SDATA hold time	T _{dh}		0.125			μs
SCLK Frequency	F _{clk}				4	MHz

9. Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

10. See Figure 5 for the definition of the timing

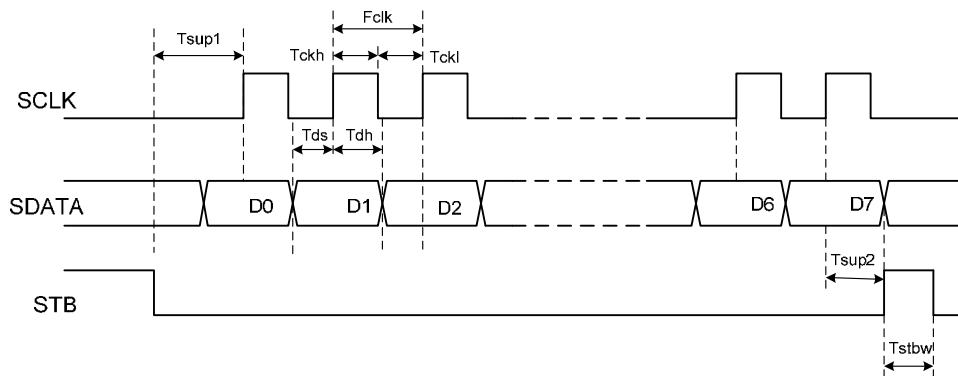


Figure 5. Serial Interface (SPI) Timing Chart

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TYPICAL CHARACTERISTICS

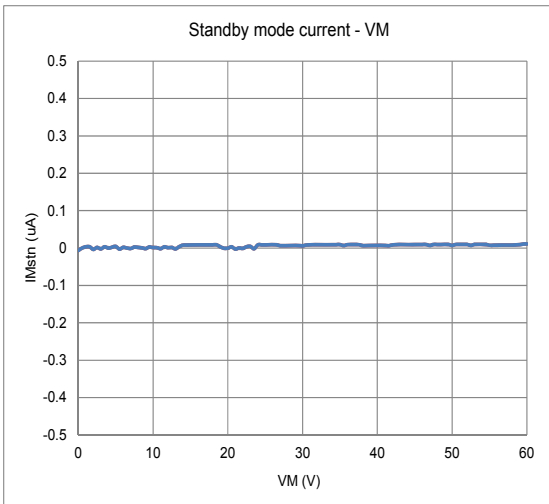


Figure 6. Standby Mode Current vs VM Voltage

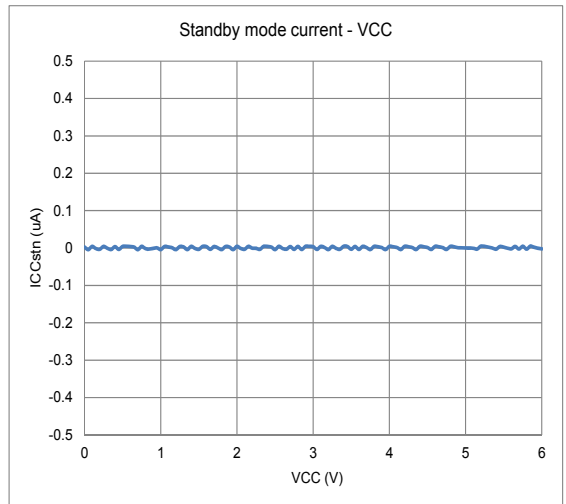


Figure 7. Standby Mode Current vs VCC Voltage

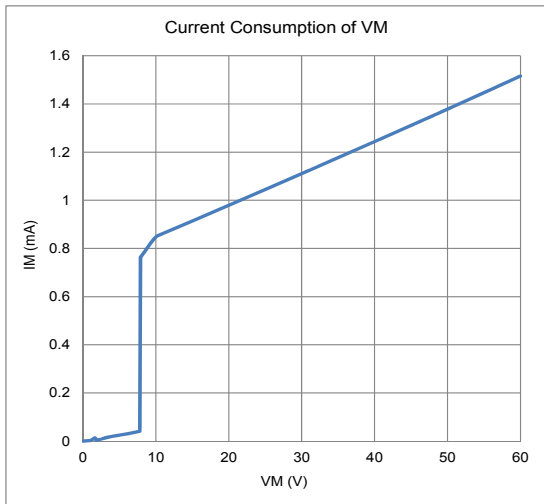


Figure 8. Current Consumption (IM) vs VM Voltage

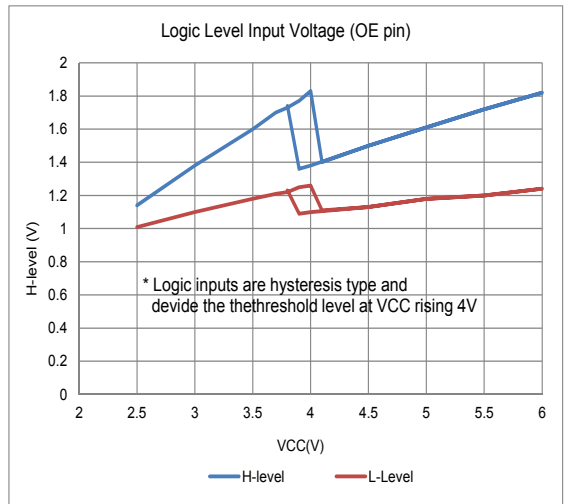


Figure 9. Logic H/L-Level Input Voltage (except ST pin) vs VCC Voltage

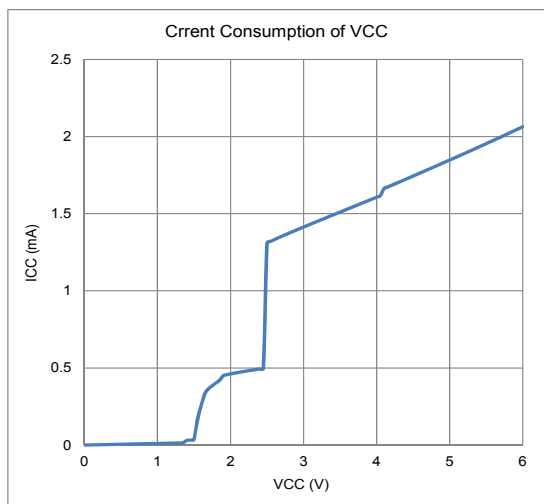


Figure 10. Current Consumption (ICC) vs VCC Voltage

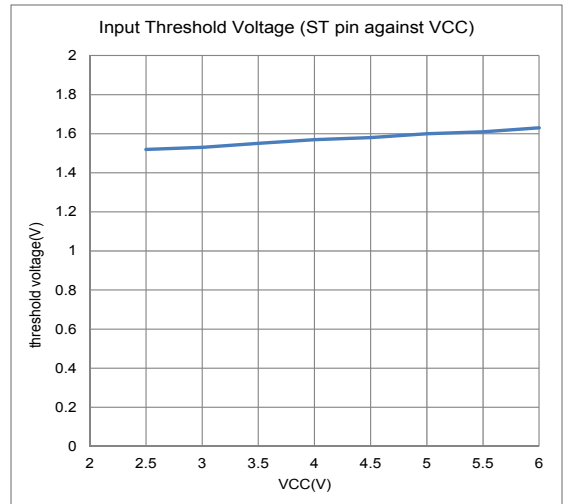


Figure 11. ST pin Input Threshold Voltage vs VCC Voltage

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TYPICAL CHARACTERISTICS (CONTINUED)

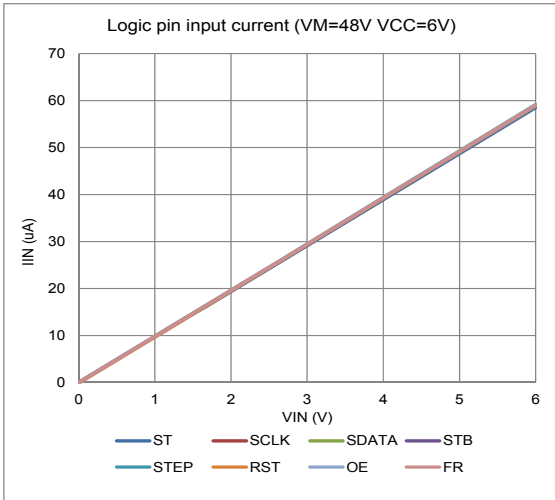


Figure 12. Logic Input Current vs Input Voltage

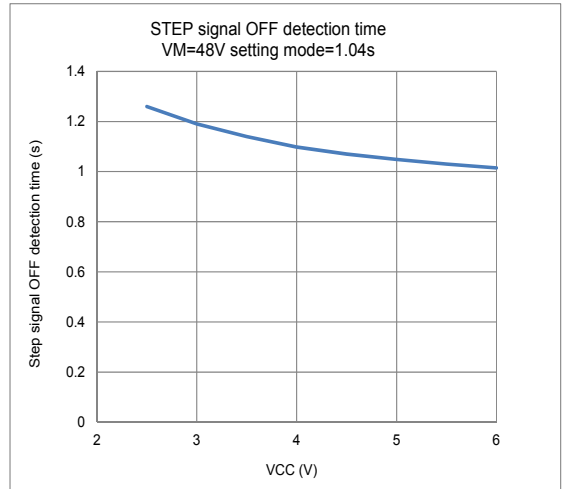


Figure 13. STEP signal OFF detection time vs VCC Voltage

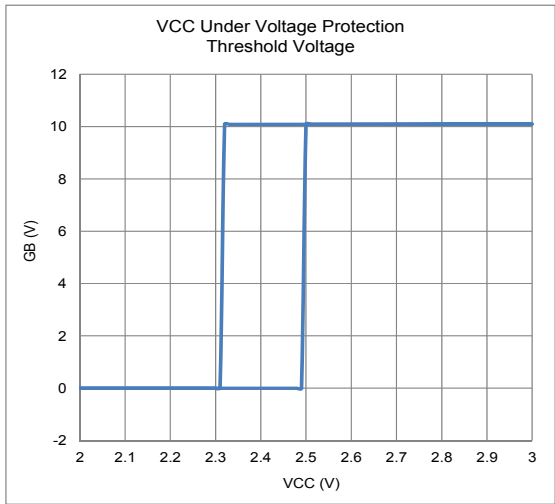


Figure 14. VCC Under-voltage Protection Threshold Voltage vs VCC Voltage

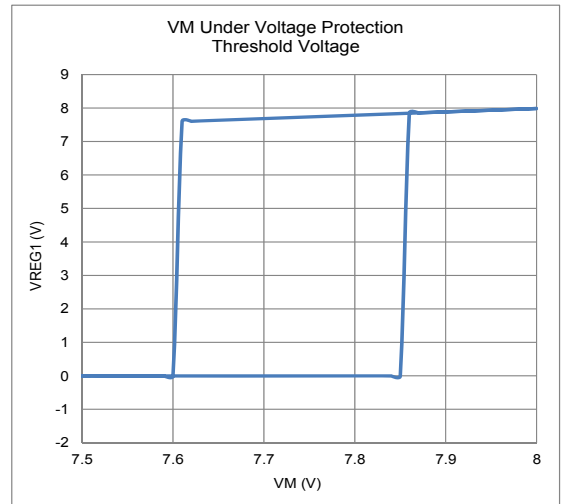


Figure 15. VM Under-voltage Protection Threshold Voltage vs VM Voltage

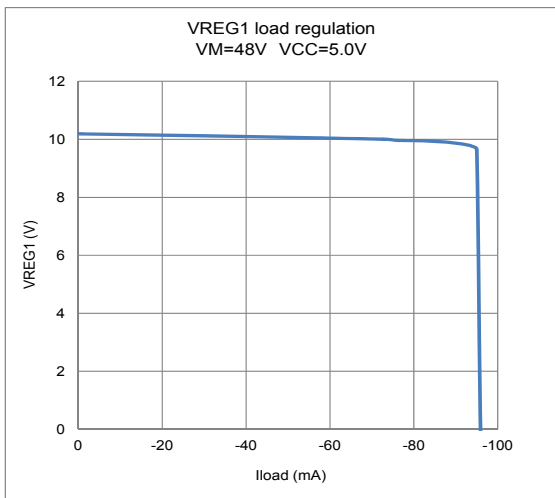


Figure 16. VREG1 Output Voltage vs VREG1 Load Current

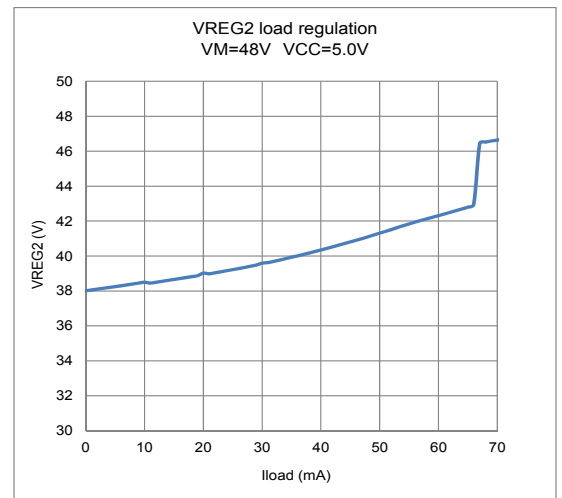


Figure 17. VREG2 Output Voltage vs VREG2 Load Current

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TYPICAL CHARACTERISTICS (CONTINUED)

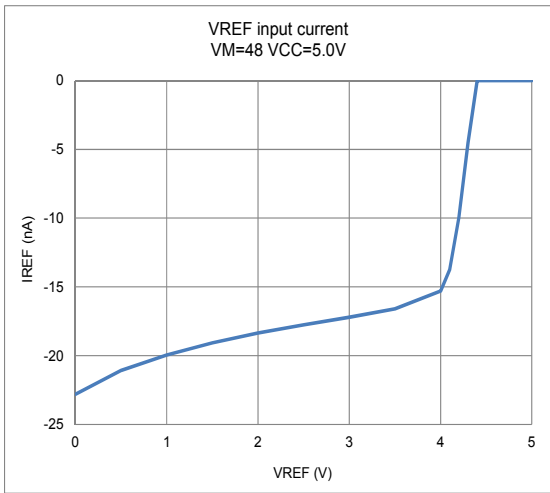


Figure 18. VREF pin Input Current (I_{REF}) vs VREF Voltage

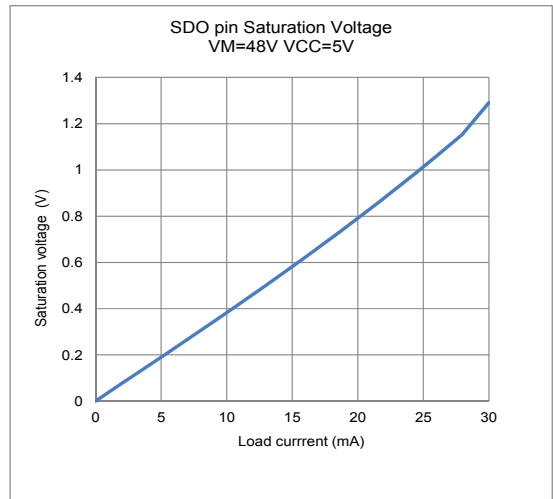


Figure 19. SDO pin Saturation Voltage vs SDO Load current

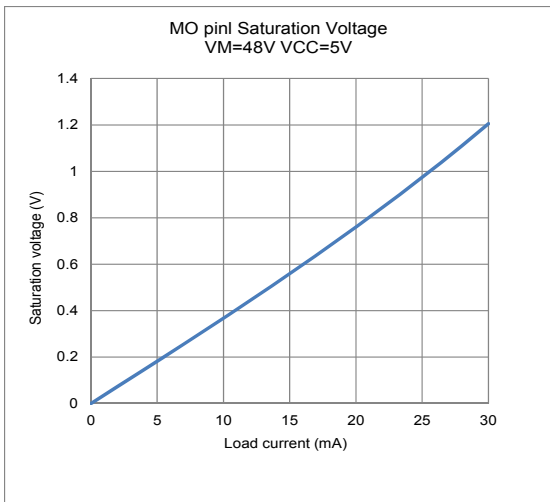


Figure 20. MO pin Saturation Voltage vs MO Load Current

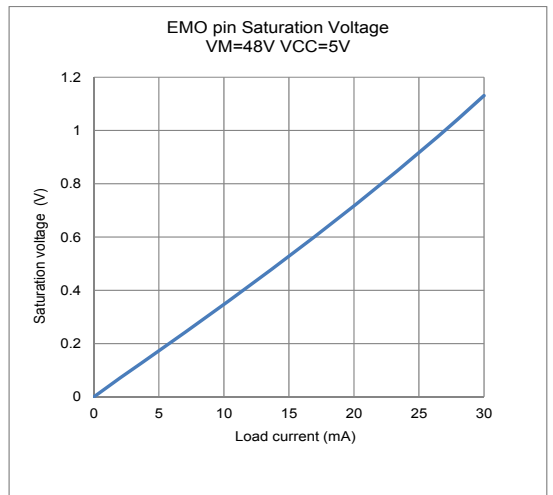


Figure 21. EMO pin Saturation Voltage vs EMO Load Current

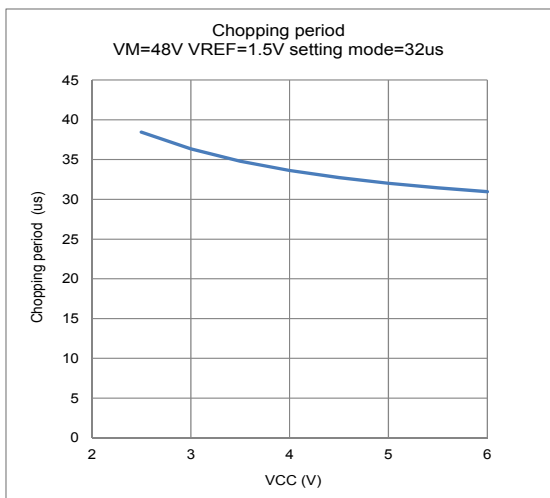


Figure 22. PWM (Chopping) Period vs VCC Voltage

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FUNCTIONAL DESCRIPTION

Power Supply Input (VM, VCC)

The LV8726 has two power supply pins, VM and VCC. VM is the motor power supply rail which is also connected externally to the power MOSFETs. VCC supplies power to internal circuits. It is highly recommended to provide a decoupling capacitor of 100µF for each position close to the VM pin and VM line of external MOSFETs on the application board.

Driver Pins (GUx, GBx and OUTx)

The pins GUx are the high side P-MOSFET gate driver outputs, and GBx are the low side N-MOSFET gate driver outputs. The pins OUTx are the voltage sense inputs used for the over-current protection function to measure the P-MOSFET voltage between drain and source. The channel pairing is shown in the following table.

Table 1: External MOSFETs Connection

Channel	P-MOS gate	P-MOS drain	N-MOS gate	Motor coil
1	GU1	OUT1	GB1	1A
	GU2	OUT2	GB2	1B
2	GU3	OUT3	GB3	2A
	GU4	OUT4	GB4	2B

Refer to the APPLICATION CIRCUIT EXAMPLE of page 3.

Internal Voltage Regulator for N-MOSFETs (VREG1)

This 10V regulator provides required biasing for low side N-MOSFET gate drivers. The output of this regulator is connected to pin VREG1. Do not use VREG1 to drive any external load. It is recommended to connect a 0.1µF decoupling capacitor between VREG1 pin and GND.

Internal Voltage Regulator for P-MOSFETs (VREG2)

This regulator provides required biasing for high side P-MOSFET gate drivers at 10V below VM. The output of this regulator is connected to pin VREG2. Do not use VREG2 to drive any external load. It is recommended to connect a 0.1µF decoupling capacitor between VREG2 and VM.

Standby Mode (ST)

When pin ST is pulled down to GND, the device enters standby mode: all power MOSFETs are turned off, and, all logic as well as the step counter are reset.

When ST pin is pulled to High, the device enters active mode. The motor is excited at the home position. A rising edge at the STEP pin will advance the motor (which direction). Refer to Table 5 of page 16 for the home position.

Table 2: Operating Mode control by ST pin

ST	Operating mode	Internal regulator
L	Standby	Standby
H	Active	Active

Initialize Step Position Pin (RST)

While pin RST is set High, the home position is excited. After RST is released (Low), the first rising edge of STEP pulse advances the step. The position monitor output (MO pin) indicates that the output state is in the home position by outputting Low level.

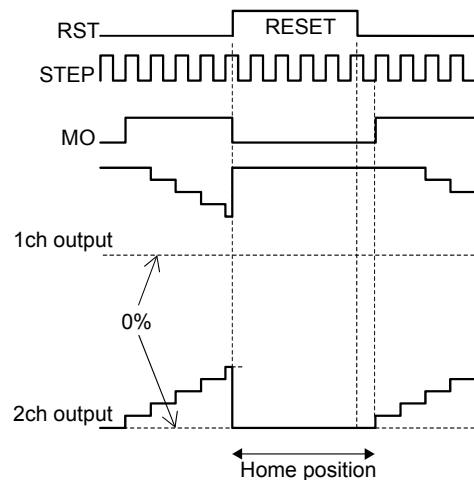


Figure 23. Initialize Step Position (RST)

Output Enable Pin (OE)

While OE pin is High, the output power MOSFETs are turned off. During the output disabled, the internal step sequencer keeps operation, advancing the step position based on the clock at STEP pin.

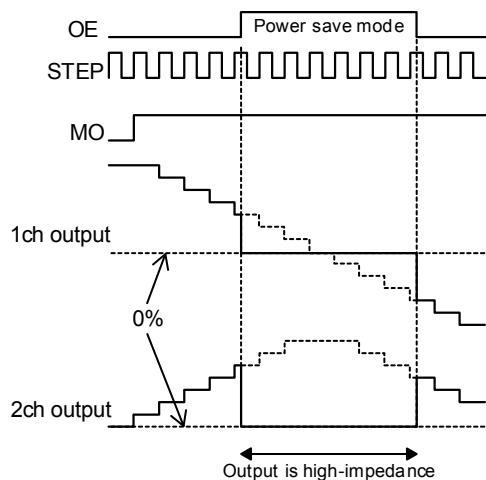


Figure 24. Example of Output Enable (OE)

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Summary of System Mode Control (ST, OE, RST)

The following table shows the summary of the system mode control function with ST, OE and RST pins.

Table 3: System Mode Control

ST	OE	RST	Output	Step position
L	*	*	High impedance	-
H	H	H	High impedance	Home position
H	H	L	High impedance	Based on STEP signal
H	L	H	Active	Home position
H	L	L	Active	Based on STEP signal

Step Clock Signal Input Pin (STEP)

A rising edge of the step clock signal at STEP pin advances the step position of the stepper motor by advancing the electrical angle of the excitation current for the motor coils. The number of steps for 90 degree of an electrical cycle (i.e. resolution) is determined by the register bits which are accessible through the serial interface.

Table 4: Step Position Control by STEP pin



ST	STEP	Operating mode
L	*	Standby mode
H		Advancing step position
H		step position is kept

Table 5: Micro Step Resolution Setting

Bit setting (D1=0, D0=0)				Micro step resolution: STEPMODE	Home position	
D5	D4	D3	D2		1ch current	2ch Current
0	0	0	0	1/2	100%	0%
0	0	0	1	1/4	100%	0%
0	0	1	0	1/8	100%	0%
0	0	1	1	1/16	100%	0%
0	1	0	0	1/32	100%	0%
0	1	0	1	1/64	100%	0%
0	1	1	0	1/128	100%	0%
0	1	1	1	1/3	100%	0%
1	0	0	0	1/6	100%	0%
1	0	0	1	1/12	100%	0%
1	0	1	0	1/36	100%	0%
1	0	1	1	1/5	100%	0%
1	1	0	0	1/10	100%	0%
1	1	0	1	1/20	100%	0%
1	1	1	0	1/50	100%	0%
1	1	1	1	1/100	100%	0%

Rotational Direction Control Pin (FR)

FR controls the progression of the electrical angle of the motor. When FR is Low, the direction is clockwise, and when FR is High, direction is counter-clockwise.

Table 6: Direction Control by FR pin

FR	Operating mode
Low	Clockwise (CW)
High	Counter-clockwise (CCW)

Figure 25 shows an example of the direction change with FR pin.

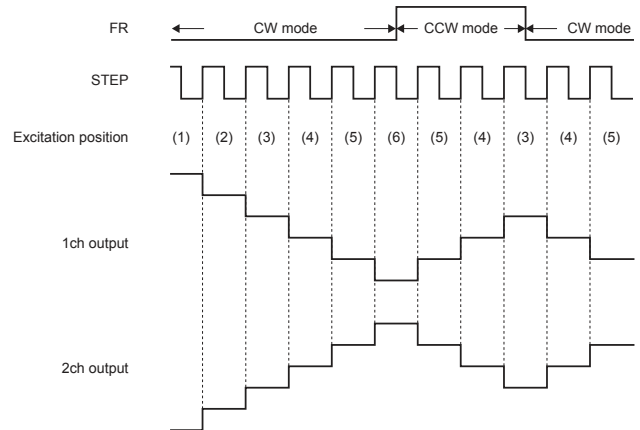


Figure 25. Example of Direction Reversal

Position Monitor Output Pin (MO)

The active low, open drain pin MO indicates the home position of the motor. An example of pin MO waveform is as shown Figure 44 and Figure 45 of page 33 and 34.

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Current Control Setting (VREF, RF1, RF2)

The LV8726 implements a current sense mechanism for each channel using external shunt resistors.

To control a coil current, a RFx pin is provided for each channel. A resistor connected at this RFx pin defines the current gain of the coil current.

The resistive voltage generated by the coil current is sensed by the RFx pin and the output duty cycle is adjusted so that the RFx voltage level is equal to the internal reference voltage (Equation 1). The reference voltage is determined by the input voltage level at VREF pin and the programmable attenuator. For this VREF pin, it is required to provide an external constant voltage source circuit. Refer to RECOMMENDED OPERATING RANGES of page 10 for VREF range.

Table 7: VREF Attenuation Ratio Setting

Bit setting (D1=0, D0=1)			VREF (Reference voltage) attenuation ratio: VREFATT
D4	D3	D2	
0	0	0	100%
0	0	1	90%
0	1	0	80%
0	1	1	70%
1	0	0	60%
1	0	1	50%
1	1	0	40%
1	1	1	30%

The output current calculation method for using of attenuation function of the VREF input voltage is as shown in Equation 1.

Equation 2 is utilized to calculate the coil peak current, I_{OUT} .

$$I_{OUT} \cdot R_{RFx} = \frac{V_{REF}}{5} \cdot ATT_{RATIO} \dots \dots \dots (1)$$

$$I_{OUT} = \frac{V_{REF} \cdot ATT_{RATIO}}{5 \cdot R_{RFx}} \dots \dots \dots (2)$$

Where,

- I_{OUT} : Coil current [A]
- R_{RFx} : Resistor between RFx and GND [Ω]
- V_{REF} : Input voltage at the VREF pin [V]
- ATT_{RATIO} : Attenuator Ratio for the VREF pin

For example, in case of

$$\begin{aligned} R_{RFx} &= 0.1[\Omega] \\ V_{REF} &= 1.5[V] \\ ATT_{RATIO} &= 1.0 (100\%) \end{aligned}$$

The coil current is

$$I_{OUT} = \frac{1.5 \times 1.0}{5 \times 0.1} = 3.0[A]$$

The LV8726 provides the built-in current vector generator. The current ratio between channel 1 and 2 are preset based on cosine and sine element individually.

PWM Constant-Current Control Ratio

The LV8726 implements constant current control drive by applying a PWM to pins GUx and GBx.

When a coil current reaches the set target value, the constant current control mechanism gets activated and performs a repetitive sequence of Charge and Decay operations as shown Figure 30-32 of page 22 and 23.

The target value is generated based on the step clock pulse number. The angle of one step θ is

$$\theta = 90^\circ \cdot S \dots \dots \dots (3)$$

Where,

- θ : Angle of micro step [deg]
- S : Micro step (1/2, ... 1/128)

The n-th current ratio can be represented by

$$\begin{pmatrix} RATIO_{CH1}(n) \\ RATIO_{CH2}(n) \end{pmatrix} [\%] = \begin{pmatrix} \cos(\theta n) \\ \sin(\theta n) \end{pmatrix} \cdot 100 \dots \dots \dots (4)$$

The n-th current value can be represented by

$$\begin{pmatrix} I_{CH1}(n) \\ I_{CH2}(n) \end{pmatrix} = I_{OUT} \begin{pmatrix} \cos(\theta n) \\ \sin(\theta n) \end{pmatrix} \dots \dots \dots (5)$$

Where,

- n : the position number of STEP from 0 to 1/S

For example, in case of

$$\begin{aligned} S &= 1/128 \text{ step} \\ n &= 32 \end{aligned}$$

The θ_{32} is

$$\theta_{32} = 90^\circ \cdot \frac{32}{128} = 22.5^\circ$$

Each current ratio is

$$\begin{aligned} RATIO_{CH1}(32) &= \cos(22.5^\circ) \cdot 100 \approx 92[\%] \\ RATIO_{CH2}(32) &= \sin(22.5^\circ) \cdot 100 \approx 38[\%] \end{aligned}$$

Equation 4 represents the theoretical calculation. The actual current ratio between the channel 1 and 2 is the preset value as shown in Table 10-12 of page 28, 30 and 32. In case of 1/128 micro step case, the preset values are plotted in Figure 41 of page 29. The current waveforms for some micro step settings are illustrated in Figure 44-1., Figure 45-1, Figure 46-1.

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Output Pin for STEP Input Monitoring (SDO)

The step clock signal at pin STEP is monitored by an internal counter. When the interval time of the rising edge is longer than timeout criteria, open drain pin SDO goes Low. The timeout period is selectable by the register bits shown in the following table. The example of detection timing is illustrated in Figure 26.

Table 8: STEP Signal OFF Detection Time Setting

Bit setting (D1=0, D0=1) D7	STEP signal OFF detection time: T _{SDO}
0	0.52sec
1	1.04sec

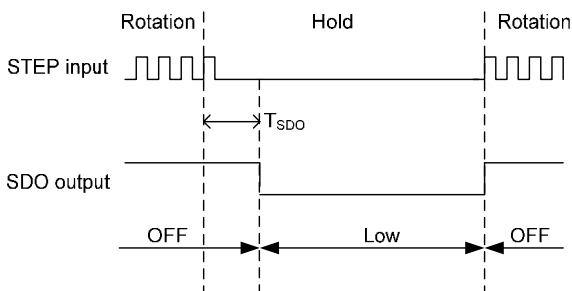


Figure 26. Example of SDO Timing

SDO Output for Current Reduction

To avoid applying high current to a motor coil for long term at one step position, the SDO output may be used to reduce the reference current. SDO is asserted when the step clock interval is longer than T_{SDO}. With the circuit is shown in Figure 27. VREF voltage can be reduced in case of an SDO assertion.

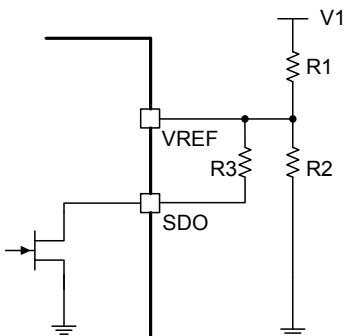


Figure 27. VREF Voltage Attenuation Circuit

Fault Detection Output (EMO)

When a fault event is detected, open drain pin EMO goes Low. The fault event is selectable by register from the following four conditions.

Table 9: Fault Detection Output Setting

Bit setting (D1=0, D0=0)		Fault detection output: EMOSEL
D7	D6	
0	0	Over-current detection
0	1	None
1	0	VM low voltage < 7.6V (typ)
1	1	Thermal Shutdown

The all fault protection functions always work regardless of the EMO output selection.

Serial Interface (ST, SDATA, SCLK, STB)

The LV8726 has registers to program settings and parameters which are accessed through the serial interface. It consists of the following three pins:

1. STB: When STB is Low, SDATA is input at the rising edge of SCLK. SCLK signal is not accepted when STB is High. The transmitted data is latched at the rising edge of STB.
2. SDATA: LSB first 8-bit word. Its direction is from external processor to the device. The written data cannot be read back.
3. SCLK: Serial clock. The device fetches each data bit at the rising edge of the clock.

The settings of 'Micro step resolution' and 'Decay mode' are taking effect at the first rising edge of STEP after a register write. Other settings are active immediately after a register change.

When more than eight bits of data were received, the latest eight bits are considered effective data. During standby mode (ST=Low), the registers cannot be accessed and all logic is reset.

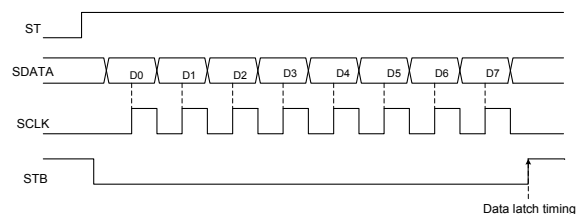


Figure 28. Serial Interface Timing Chart

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Register Map

The following Figure shows the register map. The two lowest bits are assigned for selecting one of four addresses.

D7	D6	D5	D4	D3	D2	D1	D0	Address
EMOSEL		STEPMODE				ADDR1	ADDR0	00
TSDO	DECAY		VREFATT					01
TPWM		TOFF		TBLANK				10
NA	NA	NA	NA	OCM	OCE			11

Figure 29. Register Map

ADDR D[1:0]: 00 (Address 00)

D7	D6	D5	D4	D3	D2	D1	D0
EMOSEL		STEPMODE				0	0

STEPMODE D[5:2]

Step mode setting

D5	D4	D3	D2	Micro step resolution (Step mode)
0	0	0	0	1/2
0	0	0	1	1/4
0	0	1	0	1/8
0	0	1	1	1/16
0	1	0	0	1/32
0	1	0	1	1/64
0	1	1	0	1/128
0	1	1	1	1/3
1	0	0	0	1/6
1	0	0	1	1/12
1	0	1	0	1/36
1	0	1	1	1/5
1	1	0	0	1/10
1	1	0	1	1/20
1	1	1	0	1/50
1	1	1	1	1/100

EMOSEL D[7:6]

Fault detection output select for EMO output

D7	D6	Fault detection output
0	0	Over-current detection
0	1	None
1	0	VM low voltage < 7.6V (typ)
1	1	Thermal shutdown

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ADDR D[1:0] : 01 (Address 01)

D7	D6	D5	D4	D3	D2	D1	D0
TSDO	DECAY		VREFATT			0	1

VREFATT D[4:2]

Attenuator ratio for VREF

D4	D3	D2	VREF attenuation ratio
0	0	0	100%
0	0	1	90%
0	1	0	80%
0	1	1	70%
1	0	0	60%
1	0	1	50%
1	1	0	40%
1	1	1	30%

DECAY D[6:5]

Selection of Decay mode:

In the case of 25%FAST at Mixed decay, 25% of the PWM period operates with Fast decay mode.

In the case of 50%FAST at Mixed decay, 50% of the PWM period operates with Fast decay mode.

D6	D5	Decay mode: DECAY
0	0	Mixed (25% Fast)
0	1	Mixed (50% Fast)
1	0	Slow
1	1	Fast

TSDO D[7]

STEP signal OFF detection time

D7	Step signal OFF detection time: TSDO
0	0.52sec
1	1.04sec

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ADDR D[1:0]: 10 (Address 10)

D7	D6	D5	D4	D3	D2	D1	D0
TPWM		TOFF		TBLANK		1	0

TBLANK D[3:2]

Blanking time: During this period, the mode is not switched from Charge to Decay even if the comparator detects the coil current higher than the target current.

D3	D2	Blanking time
0	0	0.5 μ s
0	1	1.0 μ s
1	0	2.0 μ s
1	1	4.0 μ s

TOFF D[5:4]

Time for turning off the MOSFETs to avoid shoot through current

D5	D4	Through current protector OFF time
0	0	0.5 μ s
0	1	1.0 μ s
1	0	2.0 μ s
1	1	4.0 μ s

TPWM D[7:6]

PWM (Chopping) period

D7	D6	PWM (Chopping) period
0	0	8 μ s
0	1	16 μ s
1	0	24 μ s
1	1	32 μ s

ADDR D[1:0]: 11 (Address 11)

D7	D6	D5	D4	D3	D2	D1	D0
NA	NA	NA	NA	OCM	OCE	1	1

OCE D[2]

Turn on/off the over-current protection function

D2	Over-current protection
0	ON
1	OFF

OCM D[3]

Over-current protection mode

D3	Over-current protection mode
0	Latch type
1	Auto reset type

The output is turned off at the over-current detection. In case of the latch type, the outputs are turned off until the standby pin ST is set Low when over-current is detected with second detection at 256 μ s after the first detection. Refer to Figure 47 of page 36 for a timing chart of latch type. In case of the auto reset type, the output is turned on with 2ms interval.

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Current Decay Mode Sequencing

LV8726 provides four selectable decay modes in one PWM period:

1. Mixed decay mode
(Ratio is register programmable)
2. Slow decay mode
3. Fast decay mode

The description of the mixed decay sequence covers all operation modes in detail. For slow and fast decay operation only, the selected mode (slow, fast) covers the entire decay period. Figures 30-32 show the sequence of events in detail.

Mixed Decay Sequence

In Mixed Decay operation the following charge-discharge sequence of three steps is applied assuming a current direction from "A" to "B". Refer to Figure 33 and Figure 34 of page 24 for the timing chart of PWM based constant-current by Mixed decay:

1. During Charge operation the voltage VM is applied to the "A" side of the coil until the coil current exceeds the target. In case the current has already exceeded the target value at the end of blanking time, the Charge

operation is directly changed over to Slow decay operation (3).

2. Next the device activates Slow decay until 50% (or 75%) of the PWM period depending on register setting. The slow decay shorts the coil to make the circulation current decrease slowly as seen in (3) event in Figure 30
3. For the remaining PWM period Fast decay is applied by reversing the voltage across the.

The operation is changed to Charge again from Fast decay. During transition from the upper MOSFET to the lower MOSFET of the same leg a programmable dead time period avoids turning on both MOSFETs at the same time. During this dead time, the coil current flows through the body diode of the MOSFET as seen in (2), (4) and (6) events in Figure 30. Dead time is determined by the register bits through the serial interface.

For Slow decay and Fast decay mode, the coil current flows through the body diode as shown in (2) event in Figure 31 and Figure 32 same as Mixed decay.

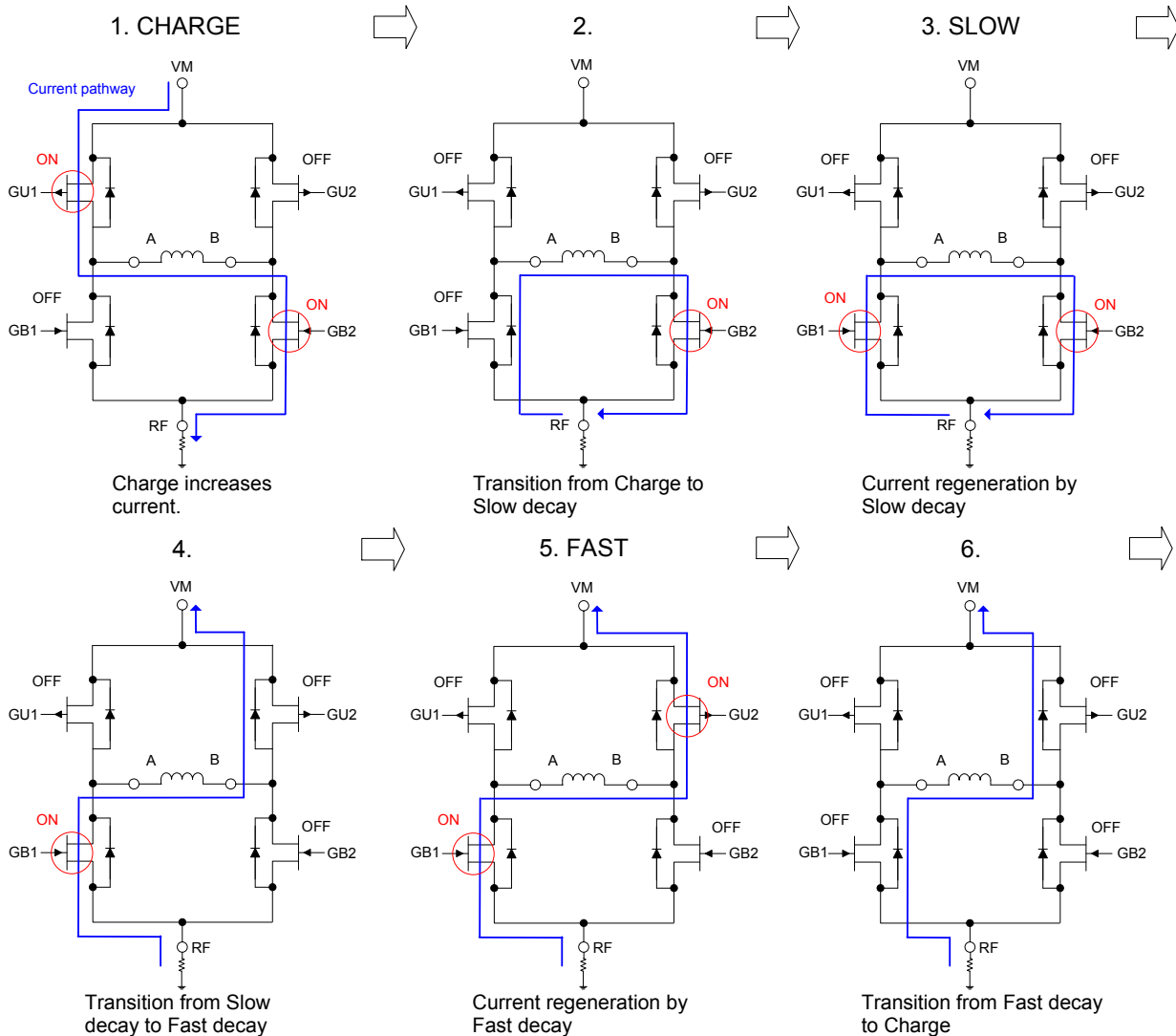


Figure 30. Mixed Decay Sequence

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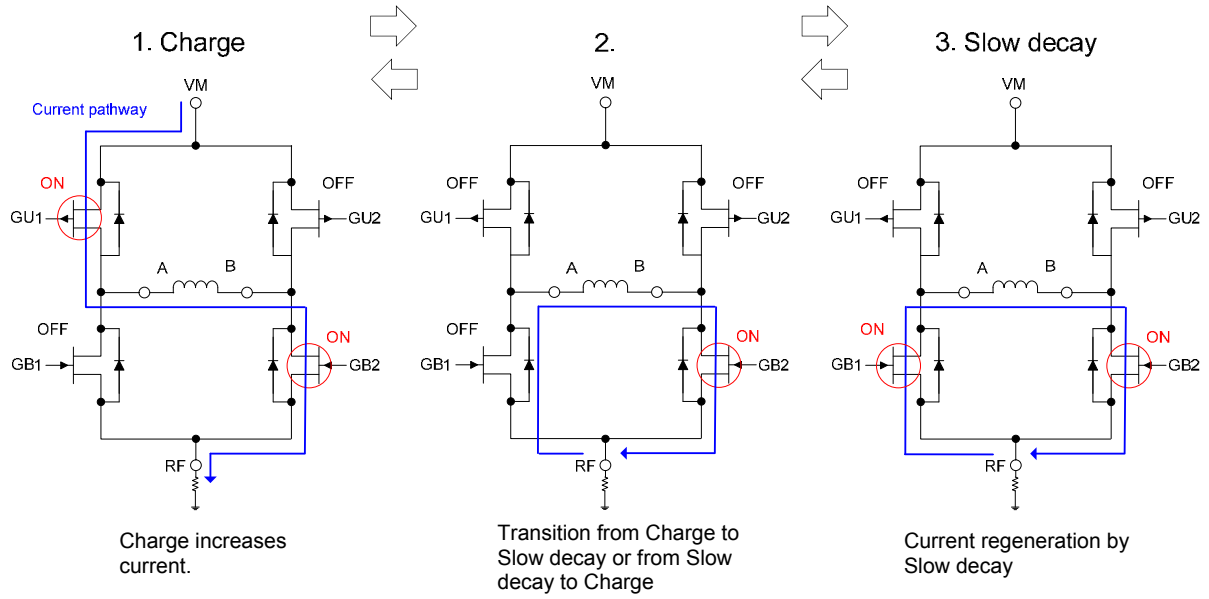


Figure 31. Slow Decay Sequence

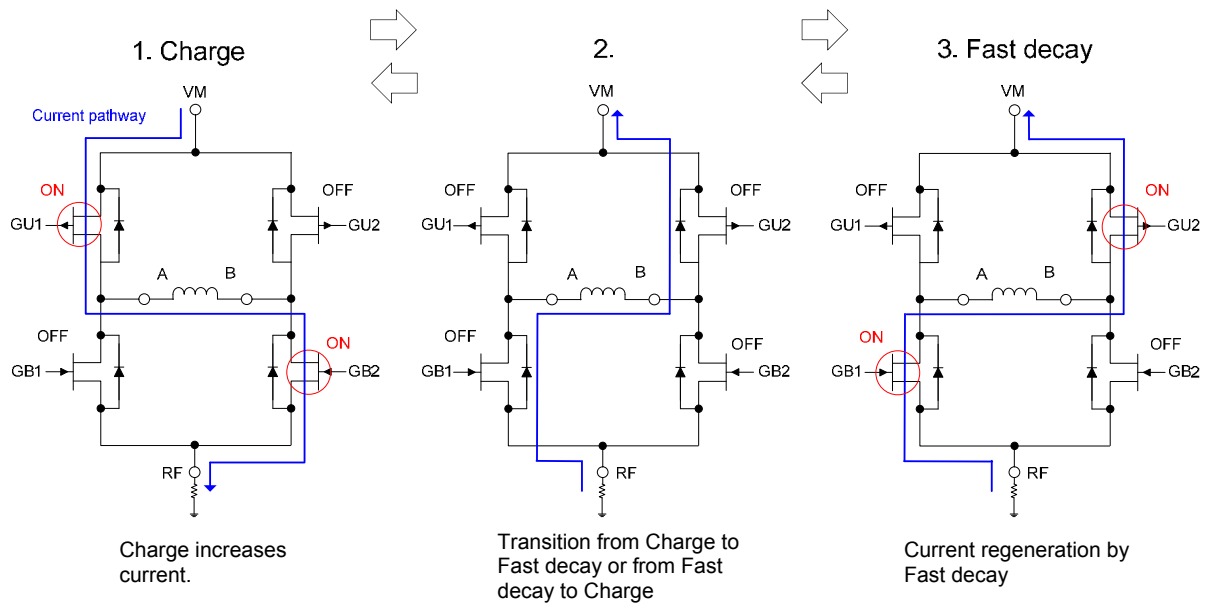


Figure 32. Fast Decay Sequence

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Timing Chart of PWM Constant-Current Control

When the current control mode is switched from Decay mode to Charge mode, a noise in the current sense resistance occurs by a recovery current, and it may erroneously detect the voltage of the sense pin. Blanking

time is provided in order to prevent this erroneous detection. During this period, the mode is not switched from Charge to Decay even if the comparator detects the coil current higher than the target current.

Mixed decay current control

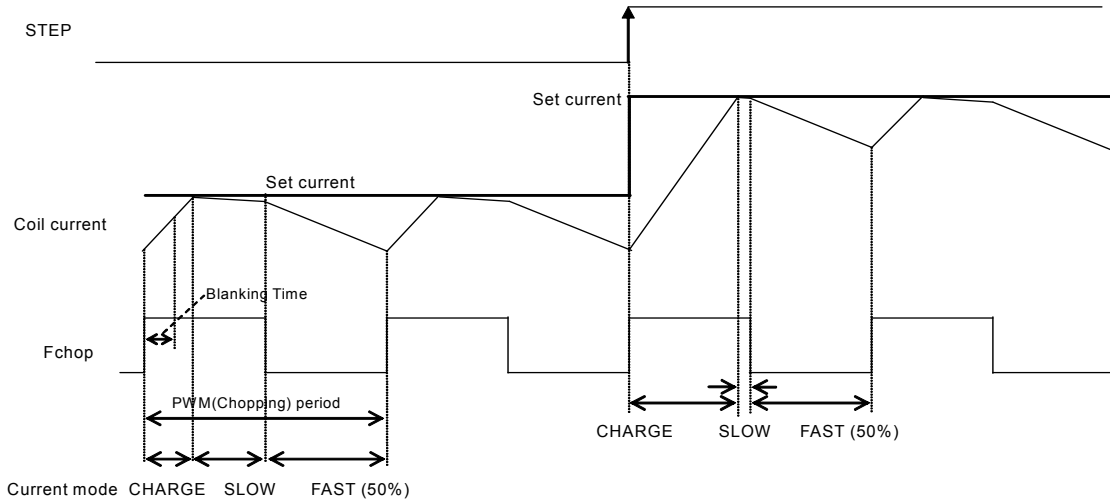


Figure 33. Mixed Decay (50%FAST) Rising Slope

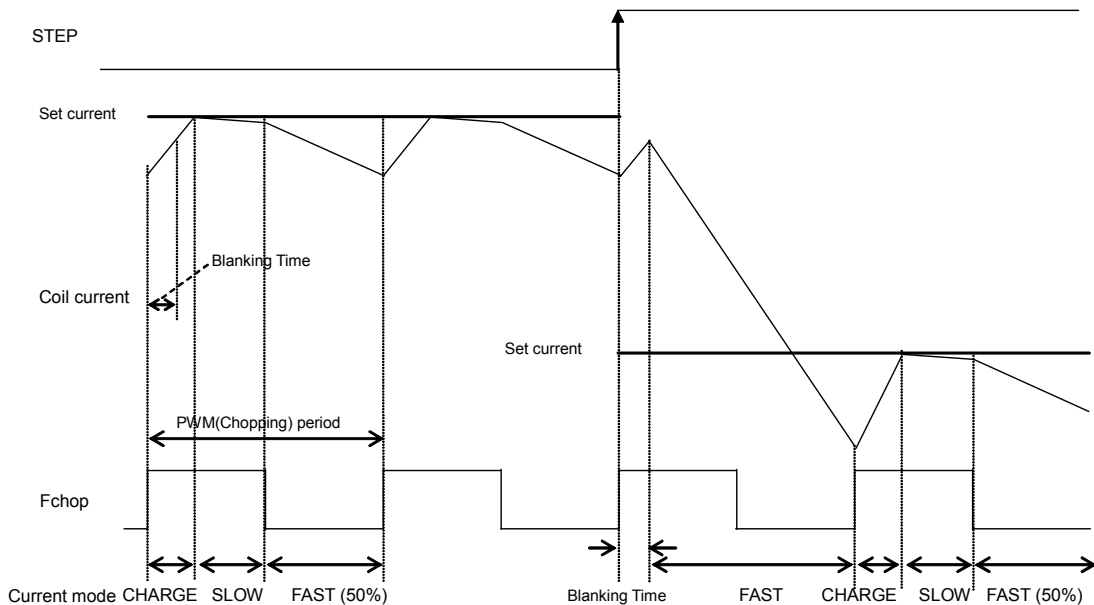


Figure 34. Mixed Decay (50%FAST) Falling Slope

When a coil current reached the set current, external MOSFETs are repeated Charge mode-> Slow decay mode-> Fast decay mode according to PWM period. The coil current is controlled constant-current by repeating three modes.

As for the Fast period, it is selectable in 50% and 25% of PWM period by serial interface.

The coil current (ICOIL) and set current (IREF) are compared in blanking time.

When $ICOIL < IREF$:

The Charge mode is continued until $ICOIL \geq IREF$. If $ICOIL$ reaches $IREF$, the mode is switched to Slow decay mode, and then is changed Fast decay mode.

When $ICOIL > IREF$:

The Fast decay mode begins. The coil current is attenuated in the Fast decay mode till one PWM period is over.

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Slow decay current control

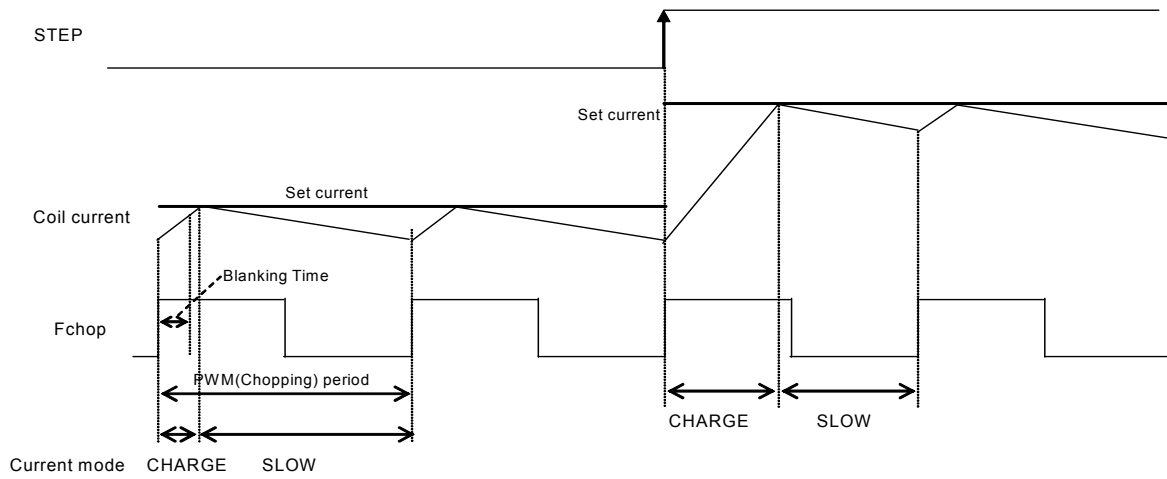


Figure 35. Slow Decay Rising Slope

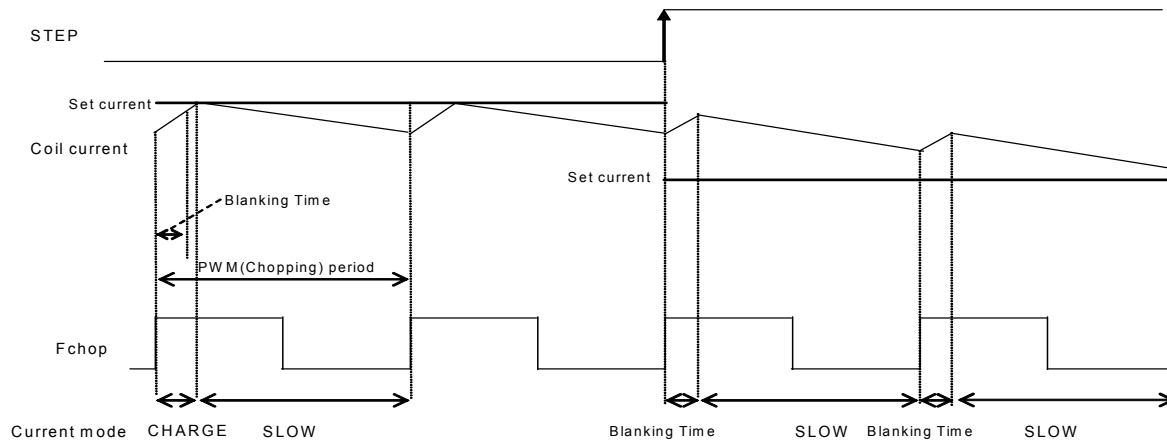


Figure 36. Slow Decay Falling Slope

When a coil current reached the set current, external MOSFETs are repeated Charge mode-> Slow decay mode

according to PWM period. The coil current is controlled constant-current by repeating two modes.

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Fast decay current control

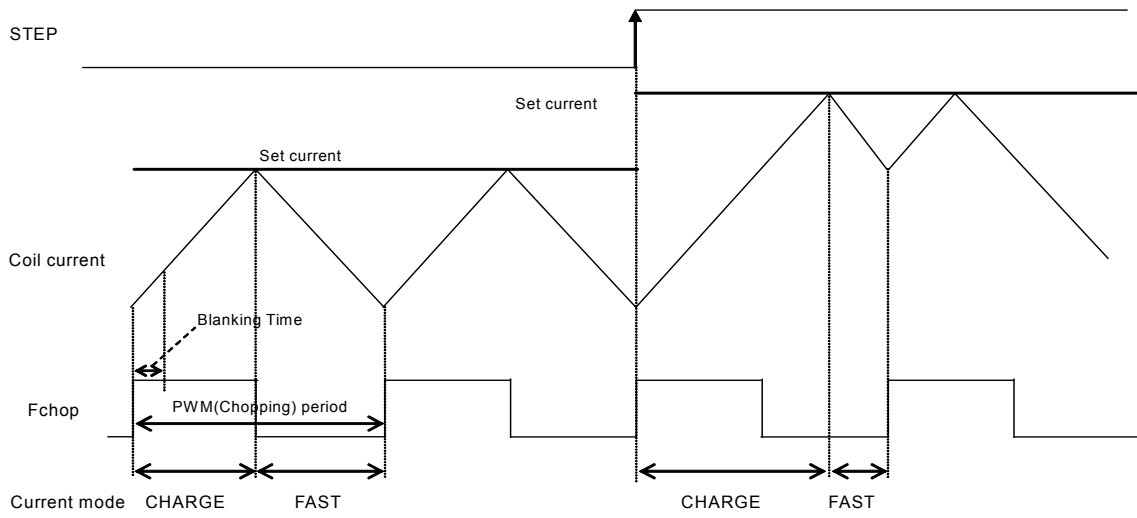


Figure 37. Fast Decay Rising Slope

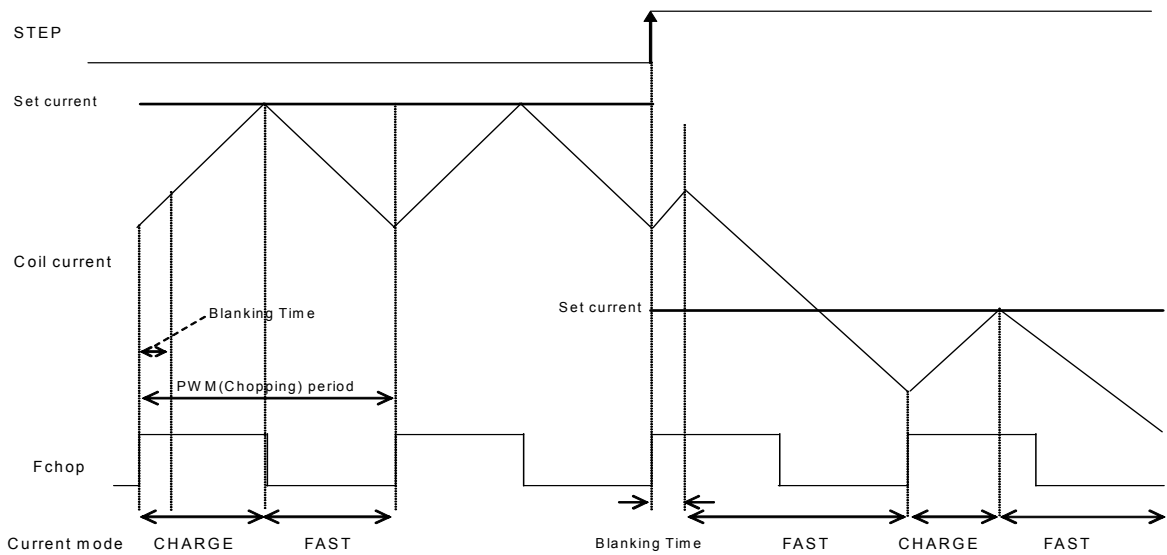


Figure 38. Fast Decay Falling Slope

When a coil current reached the set current, external MOSFETs are repeated Charge mode-> Fast decay mode

according to PWM period. The coil current is controlled constant-current by repeating two modes.

Power on/off Sequence

Power-on timing of VM power supply and VCC power supply and input timing of VREF voltage are not restricted. It is possible to power on the VCC power supply after VM and vice versa. It is also possible to supply VREF voltage first.

At startup, when all of the following conditions are met; $VM \geq 8.7V$, $VCC \geq 2.7V$, and PS = High, the internal regulators and gate voltage regulators start. It takes 100us for the regulators to get a stable output. The VREF input should not be floating, and the required input signal should be applied at least 50us, before ST is pulled High. The register access by serial interface and the logic pin control are possible at least 100us after ST has gone High.

Figure 39 shows an example of timing chart that supplied the voltage in order of VM, VCC and VREF including the access timing of the logic pins and the serial interface.

Power-off timing of VM power supply, VCC power supply and VREF voltage are not restricted. It is possible to power off the VM power supply after VCC and vice versa. It is also possible to supply VREF voltage last. VM, VCC and VREF voltage should be turned off at least 10us, after ST was pulled Low in reverse with Power-on sequence.

Figure 40 shows an example of Power-off timing chart.

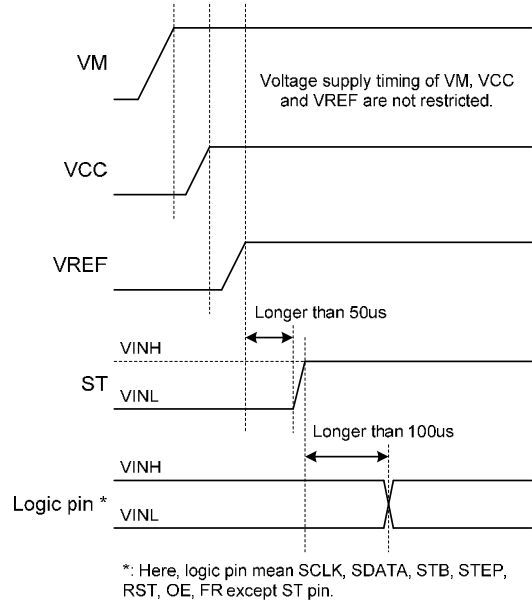


Figure 39. Timing Chart Example of Power-on Sequence

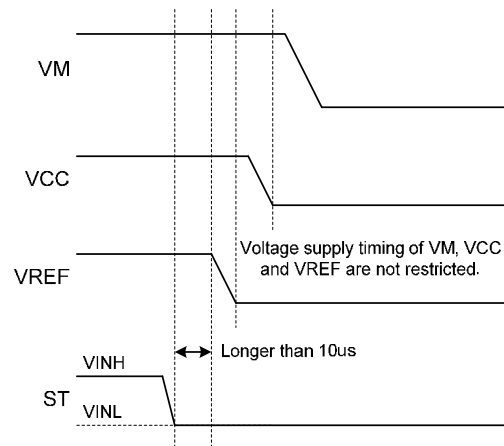


Figure 40. Timing Chart Example of Power-off Sequence

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Table 10: Current Ratio [%] for Micro Step 1/2, 1/4, 1/8, 1/16, 1/32, 1/64 and 1/128

STEP	1/128 Step		1/64 Step		1/32 Step		1/16 Step		1/8 Step		1/4 Step		1/2 Step		STEP	1/128 Step		1/64 Step		1/32 Step		1/16 Step		1/8 Step		1/4 Step		1/2 Step	
	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch		1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch
00	100	0	100	0	100	0	100	0	100	0	100	0	100	0	065	70	72												
01	100	1													066	69	72	69	72										
02	100	2	100	2											067	68	73												
03	100	4													068	67	74	67	74	67	74								
04	100	5	100	5	100	5									069	66	75												
05	100	6													070	65	76	65	76										
06	100	7	100	7											071	64	77												
07	100	9													072	63	77	63	77	63	77	63	77						
08	100	10	100	10	100	10	100	10							073	62	78												
09	99	11													074	62	79	62	79										
010	99	12	99	12											075	61	80												
011	99	13													076	60	80	60	80	60	80								
012	99	15	99	15	99	15									077	59	81												
013	99	16													078	58	82	58	82										
014	99	17	99	17											079	57	82												
015	98	18													080	56	83	56	83	56	83	56	83	56	83				
016	98	20	98	20	98	20	98	20	98	20					081	55	84												
017	98	21													082	53	84	53	84										
018	98	22	98	22											083	52	85												
019	97	23													084	51	86	51	86	51	86								
020	97	24	97	24	97	24									085	50	86												
021	97	25													086	49	87	49	87										
022	96	27	96	27											087	48	88												
023	96	28													088	47	88	47	88	47	88	47	88						
024	96	29	96	29	96	29	96	29							089	46	89												
025	95	30													090	45	89	45	89										
026	95	31	95	31											091	44	90												
027	95	33													092	43	90	43	90	43	90								
028	94	34	94	34	94	34									093	42	91												
029	94	35													094	41	91	41	91										
030	93	36	93	36											095	39	92												
031	93	37													096	38	92	38	92	38	92	38	92	38	92	38	92		
032	92	38	92	38	92	38	92	38	92	38	92	38			097	37	93												
033	92	39													098	36	93	36	93										
034	91	41	91	41											099	35	94												
035	91	42													0100	34	94	34	94	34	94								
036	90	43	90	43	90	43									0101	33	95												
037	90	44													0102	31	95	31	95										
038	89	45	89	45											0103	30	95												
039	89	46													0104	29	96	29	96	29	96	29	96						
040	88	47	88	47	88	47	88	47							0105	28	96												
041	88	48													0106	27	96	27	96										
042	87	49	87	49											0107	25	97												
043	86	50													0108	24	97	24	97	24	97								
044	86	51	86	51	86	51									0109	23	97												
045	85	52													0110	22	98	22	98										
046	84	53	84	53											0111	21	98												
047	84	55													0112	20	98	20	98	20	98	20	98	20	98				
048	83	56	83	56	83	56	83	56	83	56					0113	18	98												
049	82	57													0114	17	99	17	99										
050	82	58	82	58											0115	16	99												
051	81	59													0116	15	99	15	99	15	99								
052	80	60	80	60	80	60									0117	13	99												
053	80	61													0118	12	99	12	99										
054	79	62	79	62											0119	11	99												
055	78	62													0120	10	100	10	100	10	100	10	100						
056	77	63	77	63	77	63	77	63							0121	9	100												
057	77	64													0122	7	100	7	100										
058	76	65	76	65											0123	6	100												
059	75	66													0124	5	100	5	100	5	100								
060	74	67	74	67	74	67									0125	4	100												
061	73	68													0126	2	100	2	100										
062	72	69	72	69											0127	1	100												
063	72	70													0128	0	100	0	100	0	100	0	100	0	100	0	100	0	100
064	71	71	71	71	71	71	71	71	71	71	71	71	71																

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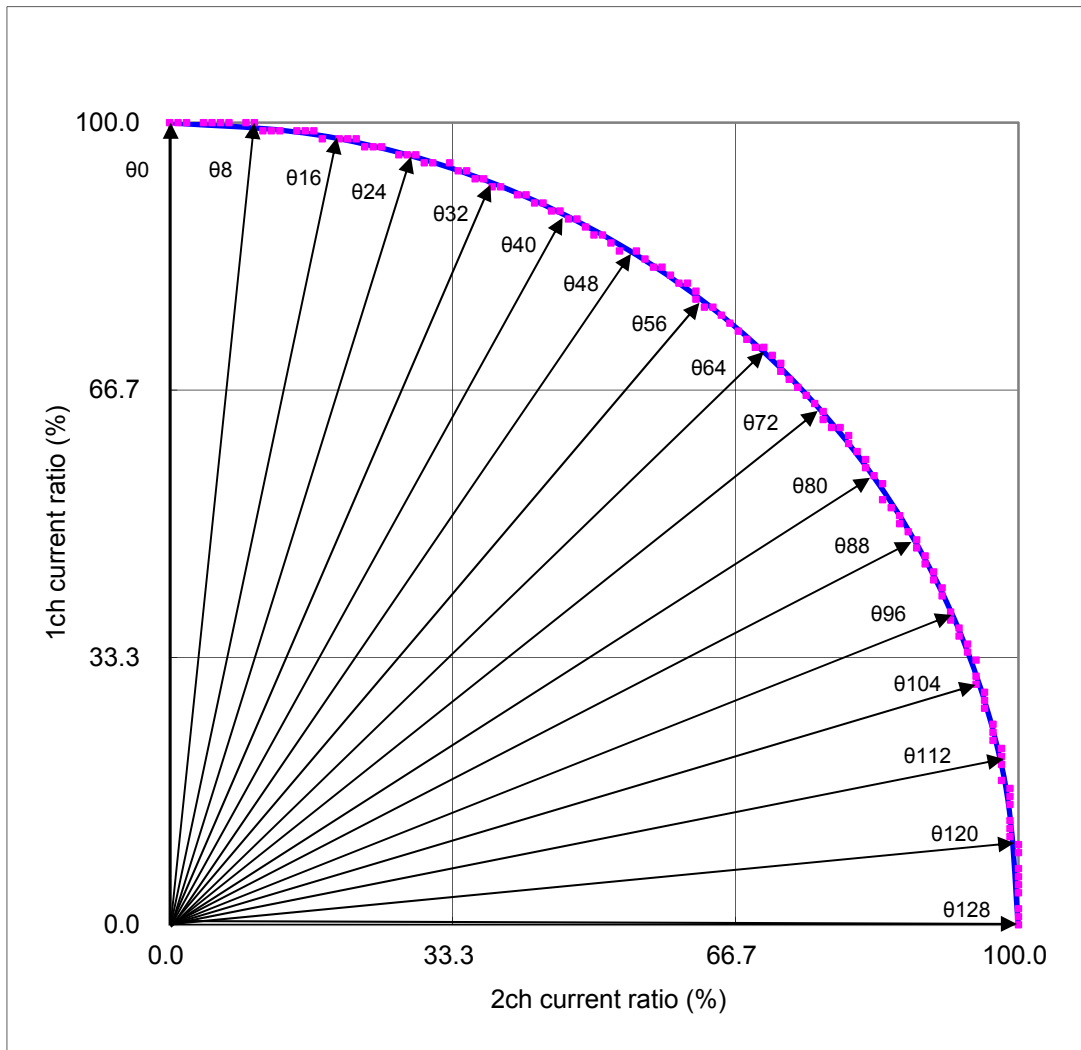


Figure 41. Vector Locus Plot for Example of 1/128 Micro Step

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Table 11: Current Ratio [%] for Micro Step 1/5, 1/10, 1/20, 1/50 and 1/100

STEP	1/100 Step		1/50 Step		1/20 Step		1/10 Step		1/5 Step		STEP	1/100 Step		1/50 Step		1/20 Step		1/10 Step		1/5 Step	
	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch		1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch
00	100	0	100	0	100	0	100	0	100	0	051	70	72								
01	100	2									052	68	73	68	73						
02	100	3	100	3							053	67	74								
03	100	5									054	66	75	66	75						
04	100	6	100	6							055	65	76			65	76				
05	100	8			100	8					056	64	77	64	77						
06	100	9	100	9							057	63	78								
07	99	11									058	61	79	61	79						
08	99	13	99	13							059	60	80								
09	99	14									060	59	81	59	81	59	81	59	81	59	81
010	99	16	99	16	99	16	99	16			061	58	82								
011	99	17									062	56	83	56	83						
012	98	19	98	19							063	55	84								
013	98	20									064	54	84	54	84						
014	98	22	98	22							065	52	85			52	85				
015	97	23			97	23					066	51	86	51	86						
016	97	25	97	25							067	50	87								
017	96	26									068	48	88	48	88						
018	96	28	96	28							069	47	88								
019	96	29									070	45	89	45	89	45	89	45	89		
020	95	31	95	31	95	31	95	31	95	31	071	44	90								
021	95	32									072	43	90	43	90						
022	94	34	94	34							073	41	91								
023	94	35									074	40	92	40	92						
024	93	37	93	37							075	38	92			38	92				
025	92	38			92	38					076	37	93	37	93						
026	92	40	92	40							077	35	94								
027	91	41									078	34	94	34	94						
028	90	43	90	43							079	32	95								
029	90	44									080	31	95	31	95	31	95	31	95	31	95
030	89	45	89	45	89	45	89	45			081	29	96								
031	88	47									082	28	96	28	96						
032	88	48	88	48							083	26	96								
033	87	50									084	25	97	25	97						
034	86	51	86	51							085	23	97			23	97				
035	85	52			85	52					086	22	98	22	98						
036	84	54	84	54							087	20	98								
037	84	55									088	19	98	19	98						
038	83	56	83	56							089	17	99								
039	82	58									090	16	99	16	99	16	99	16	99		
040	81	59	81	59	81	59	81	59	81	59	091	14	99								
041	80	60									092	13	99	13	99						
042	79	61	79	61							093	11	99								
043	78	63									094	9	100	9	100						
044	77	64	77	64							095	8	100			8	100				
045	76	65			76	65					096	6	100	6	100						
046	75	66	75	66							097	5	100								
047	74	67									098	3	100	3	100						
048	73	68	73	68							099	2	100								
049	72	70									0100	0	100	0	100	0	100	0	100	0	100
050	71	71	71	71	71	71	71	71													

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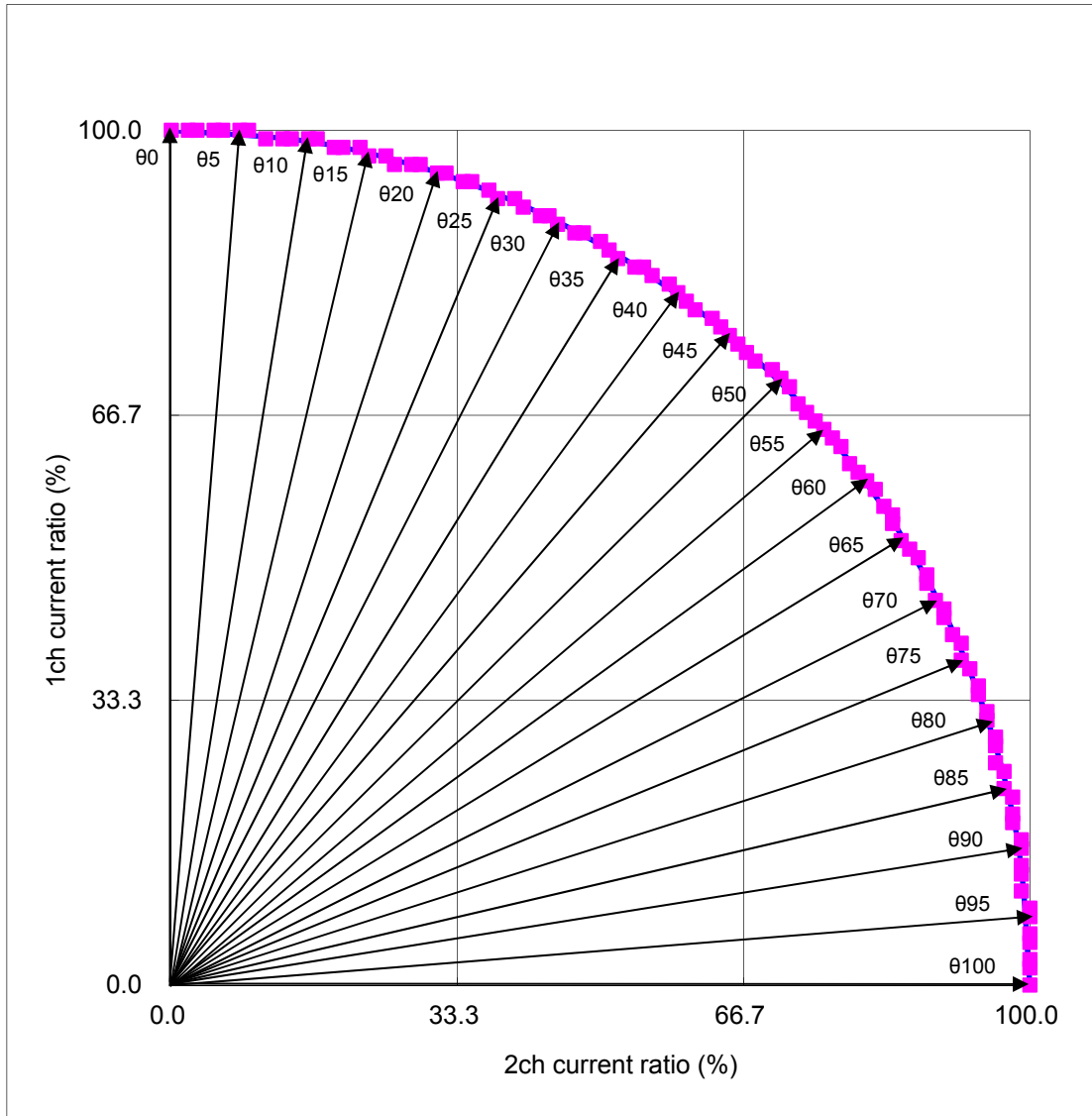


Figure 42. Vector Locus Plot for Example of 1/100 Micro Step

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Table 12: Current Ratio [%] for Micro Step 1/3, 1/6, 1/12 and 1/36

STEP	1/36 Step		1/12 Step		1/6 Step		1/3 Step		STEP	1/36 Step		1/12 Step		1/6 Step		1/3 Step	
	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch		1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch
θ0	100	0	100	0	100	0	100	0	θ19	68	74						
θ1	100	4							θ20	64	77						
θ2	100	9							θ21	61	79	61	79				
θ3	99	13	99	13					θ22	57	82						
θ4	98	17							θ23	54	84						
θ5	98	22							θ24	50	87	50	87	50	87	50	87
θ6	97	26	97	26	97	26			θ25	46	89						
θ7	95	30							θ26	42	91						
θ8	94	34							θ27	38	92	38	92				
θ9	92	38	92	38					θ28	34	94						
θ10	91	42							θ29	30	95						
θ11	89	46							θ30	26	97	26	97	26	97		
θ12	87	50	87	50	87	50	87	50	θ31	22	98						
θ13	84	54							θ32	17	98						
θ14	82	57							θ33	13	99	13	99				
θ15	79	61	79	61					θ34	9	100						
θ16	77	64							θ35	4	100						
θ17	74	68							θ36	0	100	0	100	0	100	0	100
θ18	71	71	71	71	71	71											

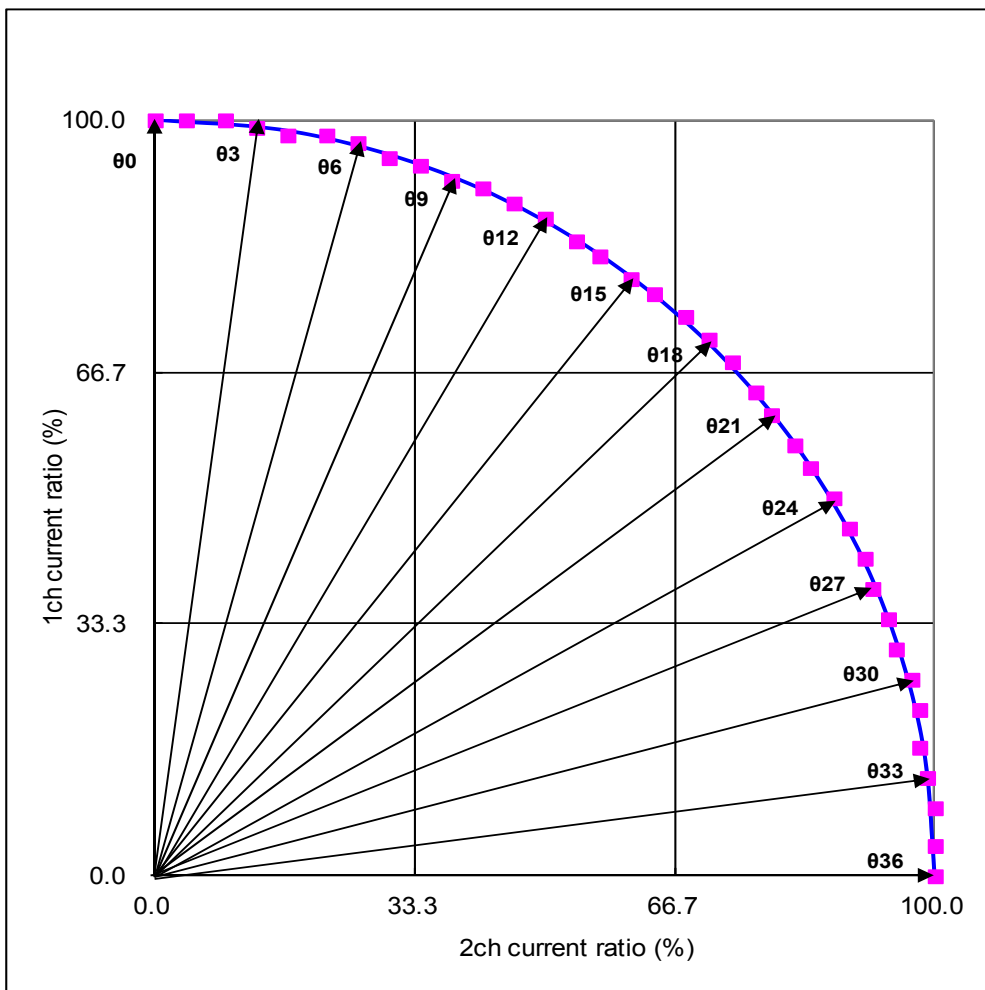


Figure 43. Vector Locus Plot for Example of 1/36 Micro Step

LV8726TA

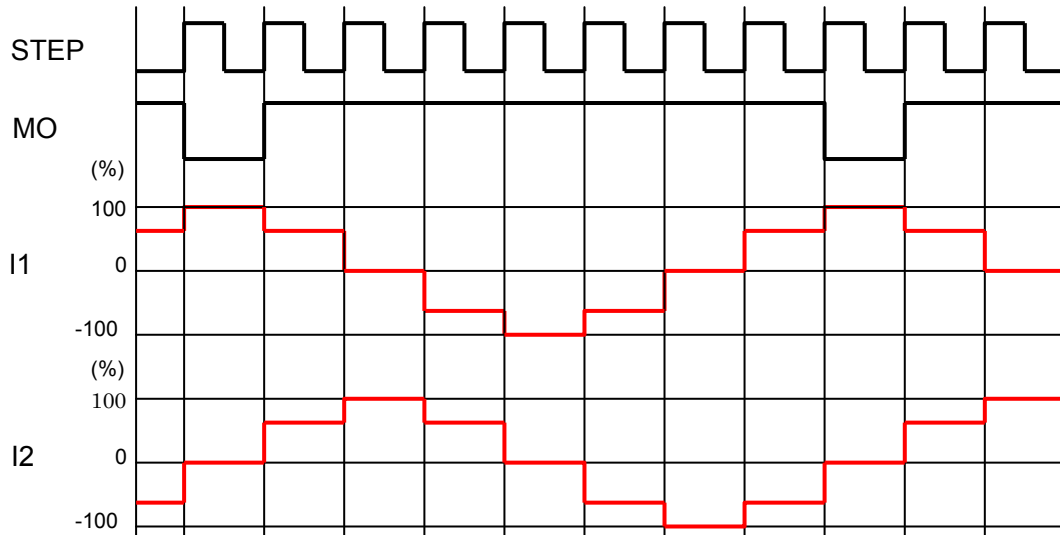


Figure 44-1. Current Waveform Example: Case of 1/2 Step CW

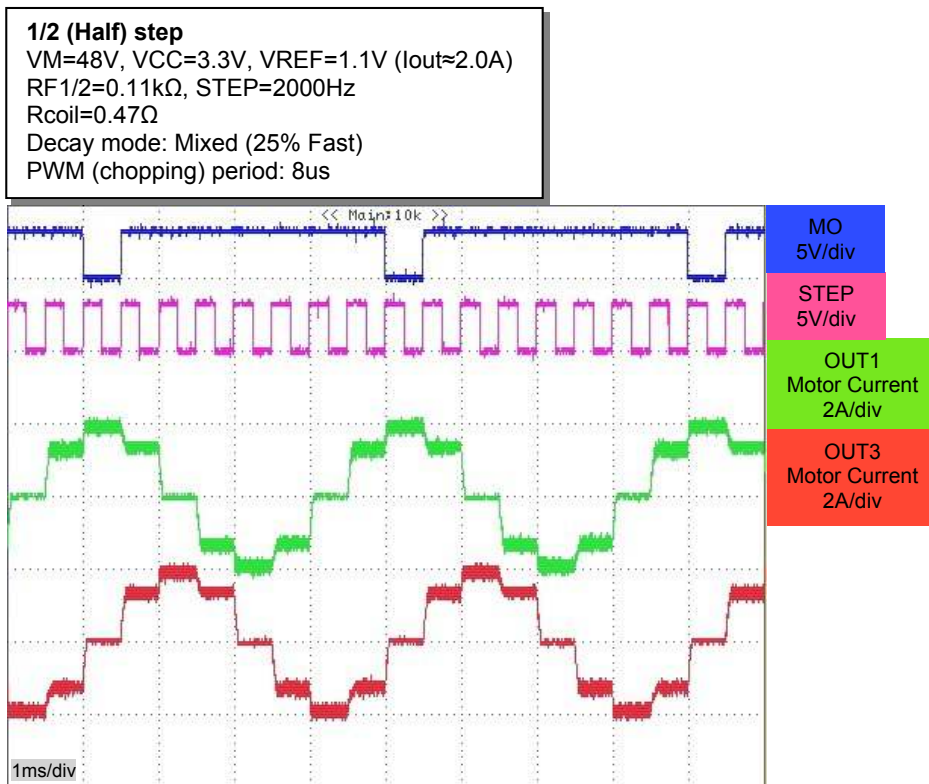


Figure 44-2. Current Waveform Example of the stepper motor: Case of 1/2 Step CW

LV8726TA

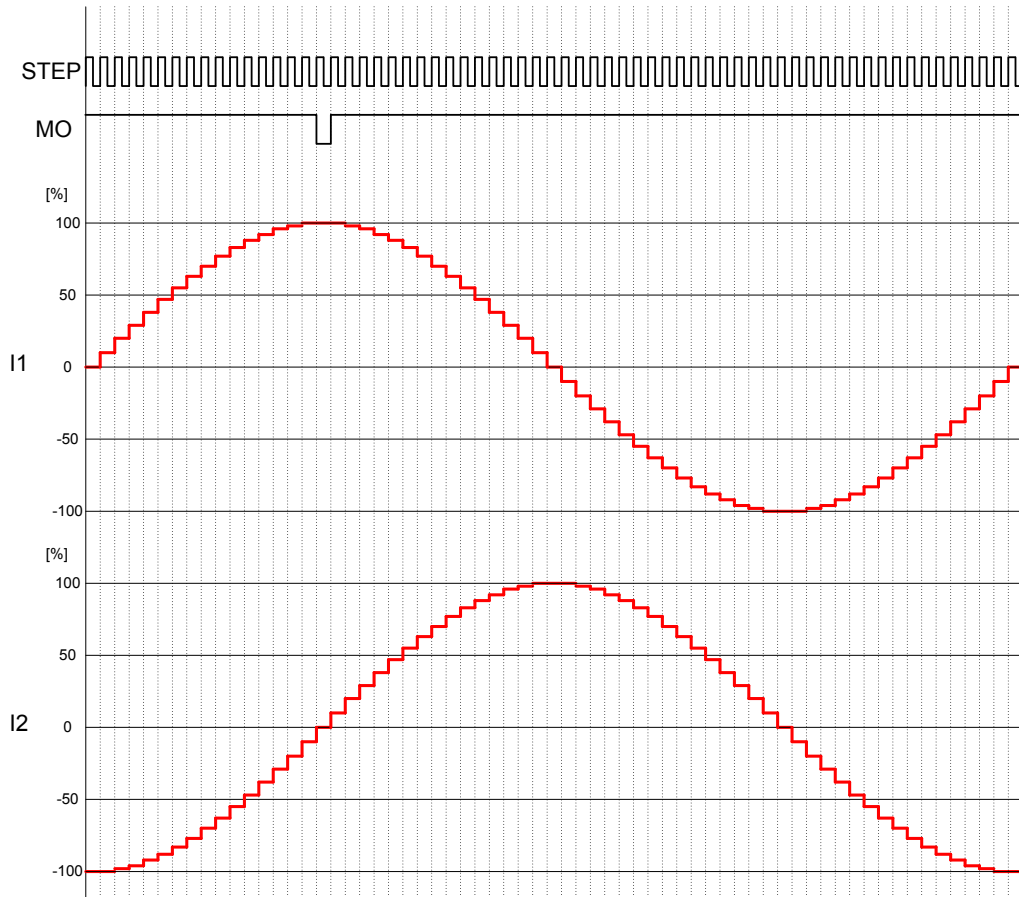


Figure 45-1. Current Waveform Example: Case of 1/16 Step CW

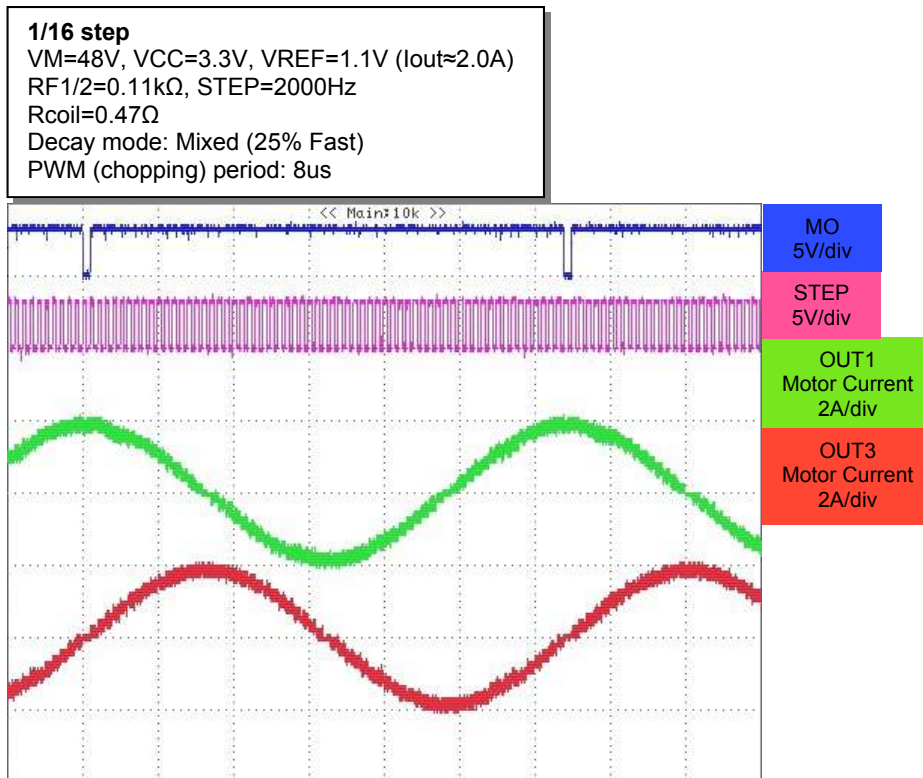


Figure 45-2. Current Waveform Example of the stepper motor: Case of 1/16 Step CW

LV8726TA

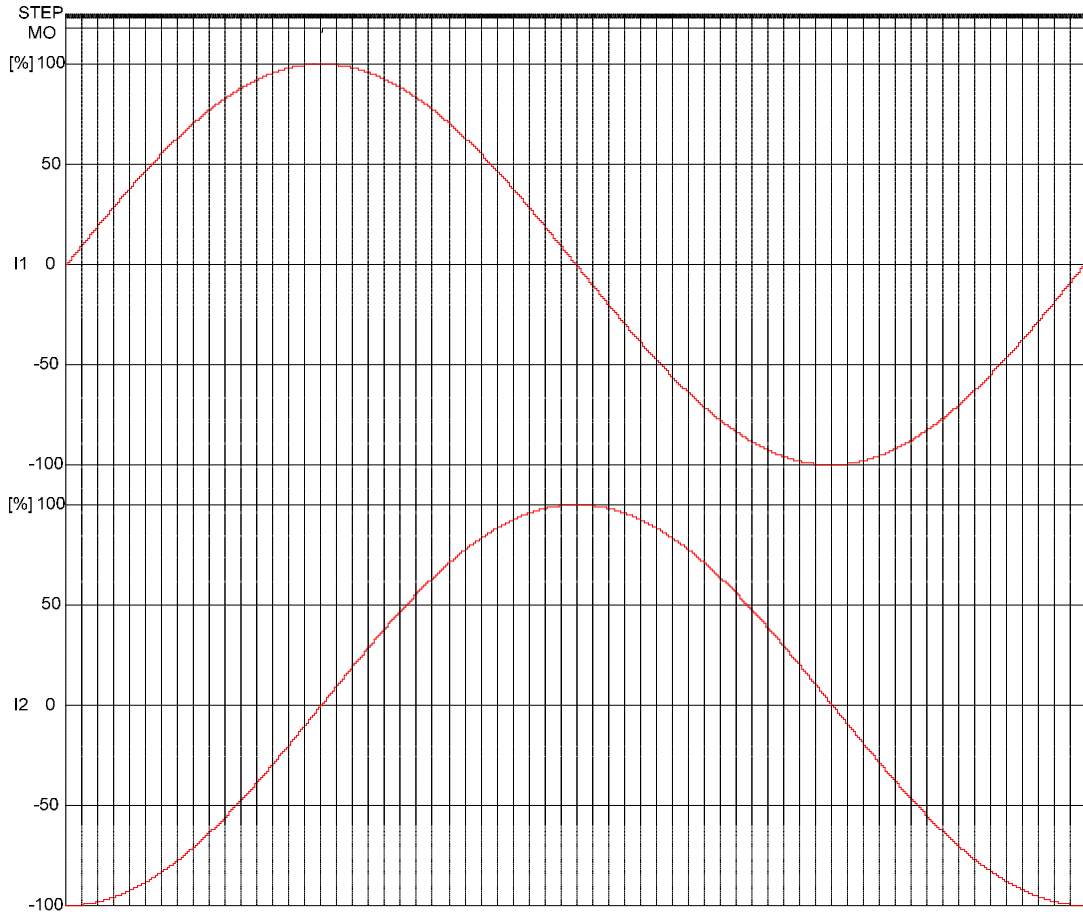


Figure 46-1. Current Waveform Example: Case of 1/128 Step CW

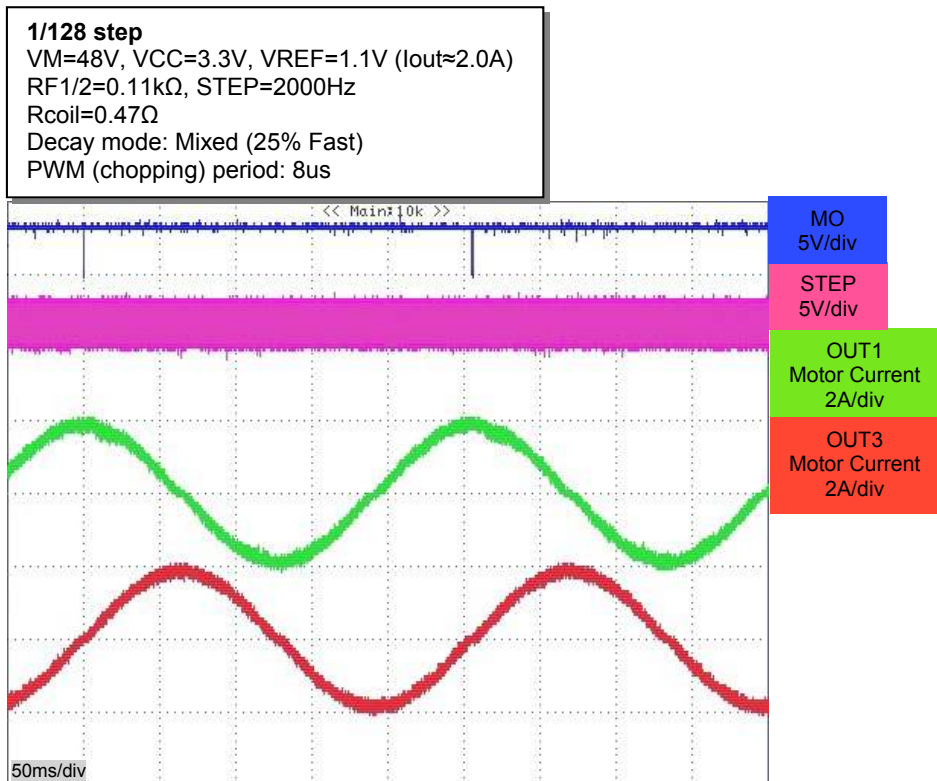


Figure 46-2. Current Waveform Example of the stepper motor: Case of 1/128 Step CW

Over-Current Protection (OCP)

The over-current covers the following three circuit short modes.

1. Output shorted to power rail
2. Output shorted to ground
3. Loads shorted to each other (two outputs of a channel)

Figure 48, Figure 49. and Figure 50. show these three circuit short modes.

The over-current is detected when the voltage between drain and source of the external P-MOSFET exceeds 3V during turn-on.

For the low side, it is detected when RFX voltage exceeds three times the RFX voltage defined by applying setting current (ATT_{RATIO} =1.0:100%). RFX pin voltage is as shown in Equation 6. Refer to equation 2 to determine Iout.

$$V_{RFX(max)} = I_{OUT(max)} \cdot R_{RFX} = \frac{V_{REF}}{5} \dots \dots (6)$$

Where,

- I_{OUT(max)} : Coil current [A] (ATT_{RATIO}=1.0: 100%)
- R_{RFX} : Resistor between RFX and GND [Ω]
- V_{RFX(max)} : RFX voltage [V] (ATT_{RATIO}=1.0: 100%)

For example, in case of

$$V_{REF} = 1.5[V]$$

$$V_{RFX(max)} = \frac{1.5}{5} [V] = 0.3[V]$$

The over-current protection voltage of low side is

$$3 \cdot V_{RFX(max)} = 3 \times 0.3[V] = 0.9[V]$$

It depends on VREF input voltage.

Latched OCP

If a coil current exceeds the detection current level for 2μs, the outputs are turned off. Subsequently, the outputs are turned on again after the timer latch period (typ: 256μs). If the output remains in over-current condition, it will be turned off again and remain latched off. In this case the programmed EMO output is asserted. The over-current protection latch (the outputs are turned off), is released by setting ST = "L".

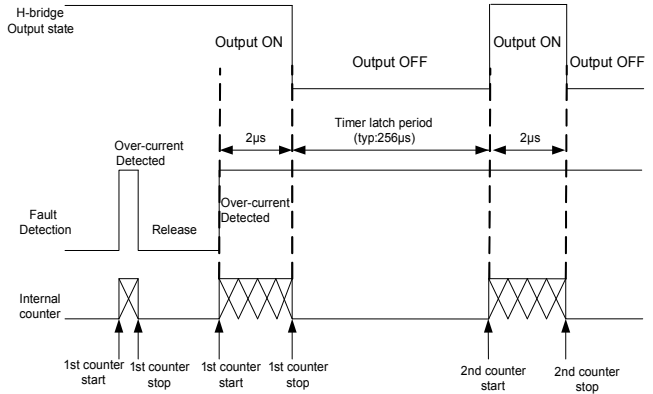


Figure 47. Timing Chart of Latched OCP

Auto Reset OCP

When the over-current is detected for 2μs (typ), the outputs turned off for 2ms (typ), and they are turned on again after 2ms. If the over-current mode still continues, over-current protection circuit is continued repetition operation of on and off until the current gets down.

Under Voltage Lockout (UVLO)

The integrated UVLO protection enables safe shutdown of the system if the voltage on either VM or VCC drops. When the VM voltage is less than 7.6V (typ), the outputs are turned off and EMO output is asserted. When the VCC voltage is less than 2.3V (typ), logic circuits are put into the reset state and the outputs are turned off.

Thermal Shutdown (TSD)

The built-in TSD protection prevents damage to the LV8726 from excessive heat. If the junction temperature T_j exceeds 180°C (typ), the outputs are turned off. If T_j goes down under 140°C (40°C of hysteresis), the outputs are automatically restored. This thermal shutdown function doesn't guarantee protection of the set and the destruction prevention.

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Short to Power

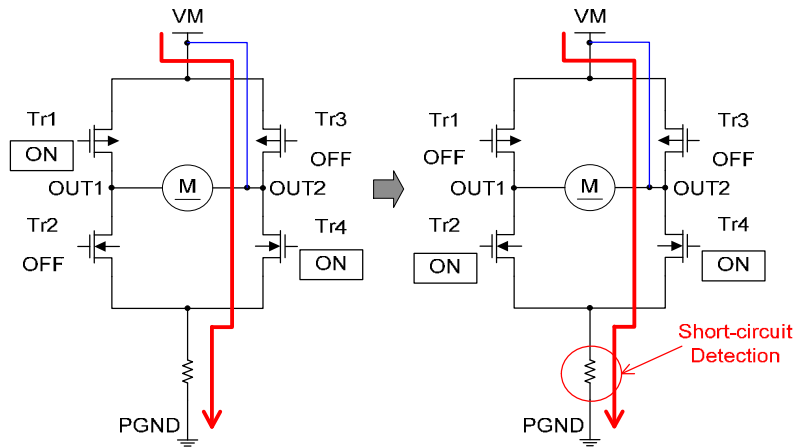


Figure 48. Short Output to Power Rail

Short to GND

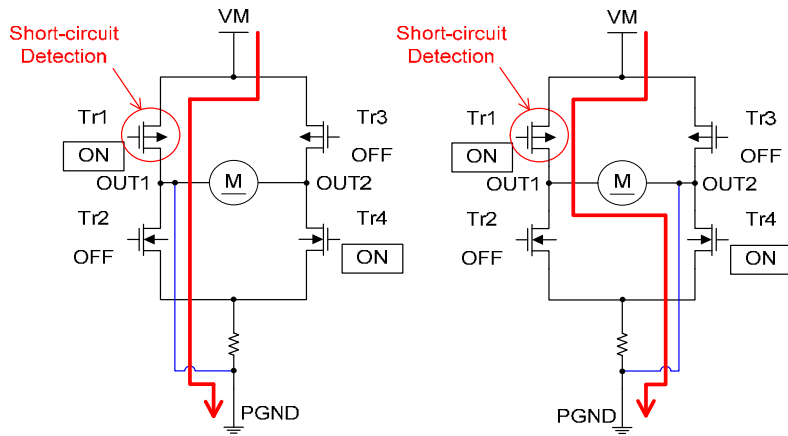


Figure 49. Short Output to GND

Load short

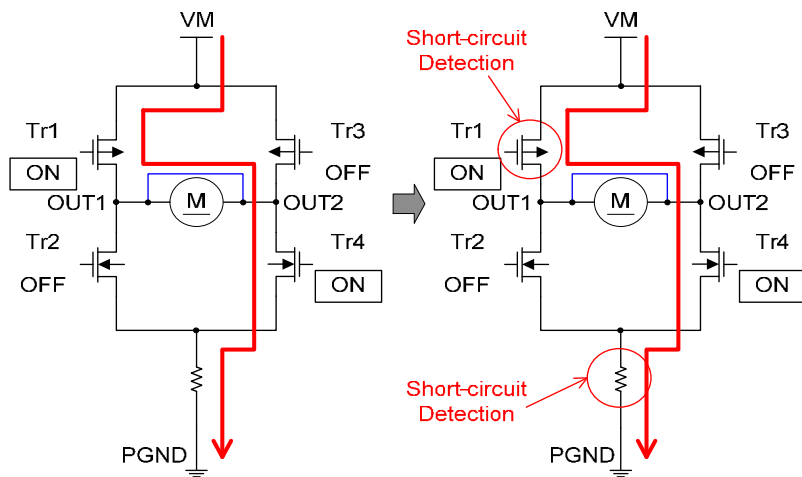


Figure 50. Short Load

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PCB LAYOUT GUIDELINES

VM and Ground routing

Make sure to connect VM and the power rail of the external P channel MOSFETs by a low impedance route. As high current flows into the source of the N channel MOSFETs, these sources must also be connected by a low impedance route to power ground (PGND). PGND and GND (pin 30) of LV8726 must also be connected by low impedance traces.

Exposed Pad

The exposed pad is connected to the frame of the LV8726 and must be connected to GND. When GND

(pin 30) and PGND of the N channel MOSFETs are in the same plane, connect the exposed pad to same GND. Do not connect the exposed pad to the PGND only. If GND (30pin) and PGND are divided, connect it to GND (30pin).

Thermal Test conditions

Size: 90mm × 90mm × 1.6mm (two layers PCB)

Material: Glass epoxy

Copper wiring density: L1 = 55% / L2 = 70%

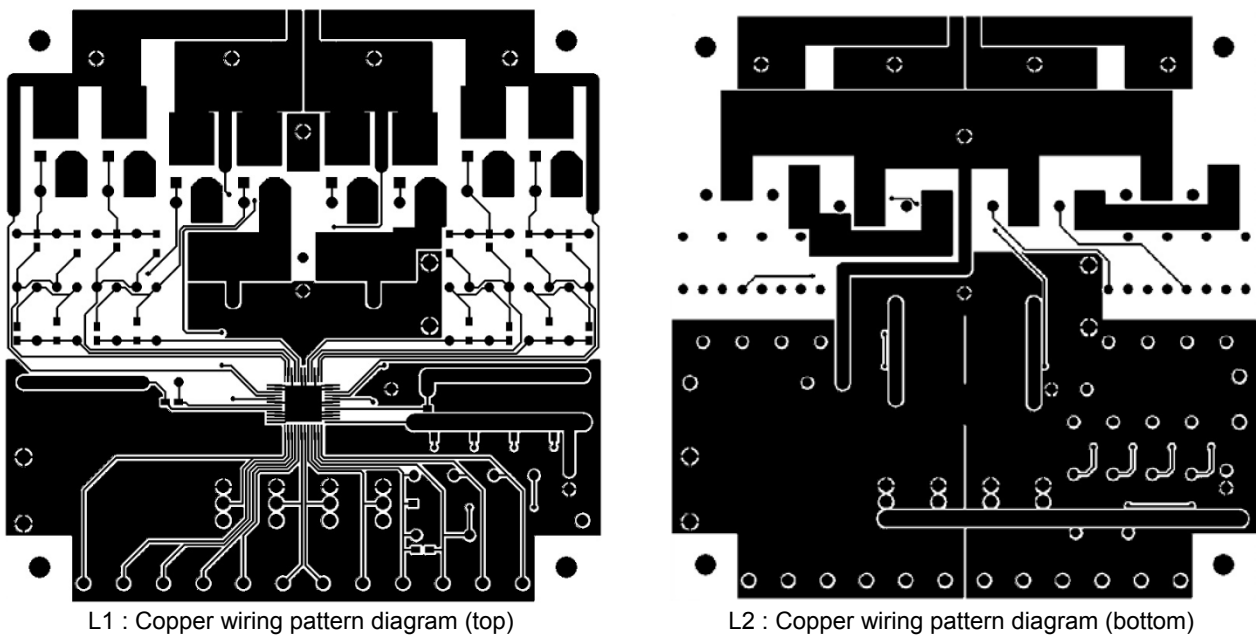


Figure 51. Pattern Diagram of Top and Bottom Layer

Recommendation

The thermal data provided is for the thermal test condition where 90% or more of the exposed die pad is soldered.

It is recommended to derate critical parameters for a safe design. Electrical parameters that are recommended to be derated are: operating voltage, operating current, junction temperature, and device power dissipation. The recommended derating for a safe design is as shown below:

- Maximum 80% for operating voltage
- Maximum 80% for operating current
- Maximum 80% for junction temperature

Check solder joints and verify reliability of solder joints for critical areas such as exposed die pad, power pins and grounds.

Any void or deterioration in solder joint of these critical areas may cause deterioration in thermal conduction and lead to thermal destruction of the device.

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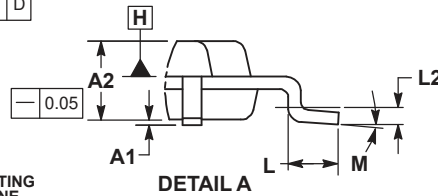
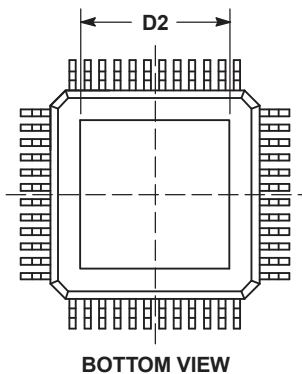
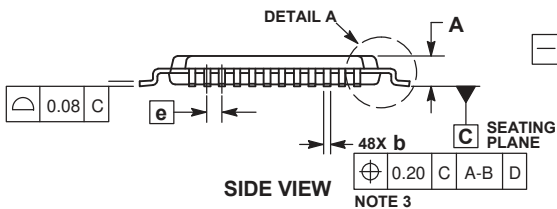
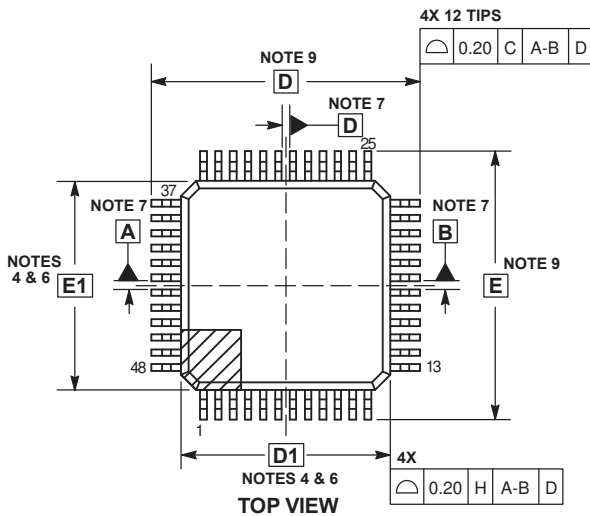
PACKAGE DIMENSIONS

unit : mm

TQFP48 EP 7x7, 0.5P

CASE 932F

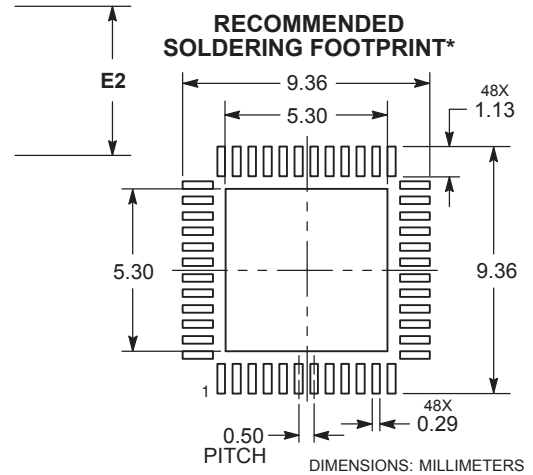
ISSUE C



DIM	MILLIMETERS	
	MIN	MAX
A	0.95	1.25
A1	0.05	0.15
A2	0.90	1.20
b	0.17	0.27
D	9.00 BSC	
D1	7.00 BSC	
D2	4.90	5.10
E	9.00 BSC	
E1	7.00 BSC	
E2	4.90	5.10
e	0.50 BSC	
L	0.45	0.75
L2	0.25 BSC	
M	0°	7°

NOTES:

1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL BE 0.08 MAX. AT MMC. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD IS 0.07.
4. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. DIMENSIONS D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE INCLUDING MOLD MISMATCH.
5. THE TOP PACKAGE BODY SIZE MAY BE SMALLER THAN THE BOTTOM PACKAGE SIZE BY AS MUCH AS 0.15.
6. DATUMS A-B AND D ARE DETERMINED AT DATUM PLANE H.
7. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
8. DIMENSIONS D AND E TO BE DETERMINED AT DATUM PLANE C.



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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